Overview

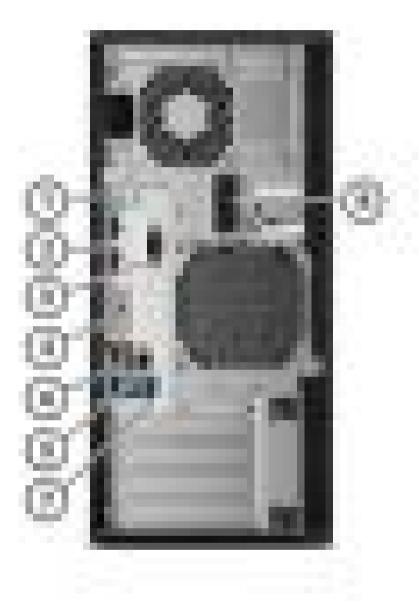
HP Z2 Tower G4 Workstation



- 1. Power Button
- 2. Headphone/Microphone
- 3. 1 USB 3 port
- 4. 1 USB 3 Battery Charging Port
- 5. Optional Type-C Battery Charging Port

- 6. Optional SD Card Reader
- 7. External 5.25" bay

Overview



- 1. 1 Audio Line In, 1 Audio Line Out,
- 2. 2 DisplayPortTM (DP 1.2) output from Intel[®] UHD graphics (available on selected processors only)
- 3. Optional Serial Port
- 4. 1 flex IO module for 2nd LAN/VGA/HDMI/DP/USB Type-C/ThunderboltTM 3.0 (ThunderboltTM requires x4 PCIe Add in card)
- 5. RJ-45 to integrated GBe
- 6. 2 USB 2.0
- 7. 4 USB 3.0
- 8. Optional WLAN/BT Antenna

Form	Factor	Minitower

Operating Systems Preinstalled:

• Windows 10 Home 64*

Overview

- Windows 10 Pro 64*
- Windows 10 Pro (National Academic License)*
- Windows 10 Pro for Workstations HP recommends Windows 10 Pro *
- HP Linux[®]-ready
- Supported:
 - Red Hat[®] Enterprise Linux[®] Workstation (1 year paper license available; Preinstall not available)

* Not all features are available in all editions or versions of Windows. Systems may require upgraded and/o separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.microsoft.com.

NOTE: For detailed OS/hardware support information for Linux, see: http://www.hp.com/support/linux_hardware_matrix

Processors

Name	Cores	Clock Speed (GHz)	Intel® Turbo Boost Technology ³	Cache (MB)	Memory Speed (MT/s)	Hyper- Threading	Integrated Graphics	Featuring Intel® vPro TM Technology ⁴	16GB Intel® Optane TM memory ^{2,*}	TDP (W)
Intel® Xeon® processor E-2176G ¹	6	3.7	4.7	12	2666	Y	Intel® UHD Graphics P630	Y	N	80W
Intel® Xeon® processor E-2174G ¹	4	3.8	4.7	8	2666	Y	Intel® UHD Graphics P630	Y	N	71W
Intel® Xeon® processor E-2144G ¹	4	3.6	4.5	8	2666	Y	Intel® UHD Graphics P630	Y	N	71W
Intel® Xeon® processor E-2136 ¹	6	3.3	4.5	12	2666	Y	N/A	Y	N	80W
Intel® Xeon® processor E-2126G ¹	6	3.3	4.5	12	2666	N	Intel® UHD Graphics P630	Y	N	80W
Intel® Xeon® processor E-2124G ¹	4	3.4	4.3	8	2666	N	Intel® UHD Graphics P630	Y	N	71W
Intel® Xeon® processor E-2104G ¹	4	3.2	N/A	8	2666	N	Intel [®] UHD Graphics P630	Y	N	65W
	•					*	*			
Intel® Core TM i7-8700K processor ¹	6	3.7	4.7	12	2666	Y	Intel® UHD Graphics 630	Y	N	95W
Intel [®] Core TM i7+8700K processor (Core i7 and 16GB Intel [®] Optane TM memory) ^{1,2,*}	6	3.7	4.7	12	2666	Y	Intel® UHD Graphics 630	Y	Y	95W
Intel® Core TM i7-8700 processor ¹	6	3.2	4.6	12	2666	Y	Intel® UHD Graphics 630	Y	N	65W

Overview

Intel [®] Core TM i7+8700 processor (Core i7 and 16GB Intel [®] Optane TM memory) ^{1,2,*}	6	3.2	4.6	12	2666	Y	Intel® UHD Graphics 630	Y	Y	65W
Intel® Core TM i5-8600 processor ¹	6	3.1	4.2	9	2666	N	Intel® UHD Graphics 630	Y	N	65W
Intel [®] Core TM i5+8600 processor (Core i5 and 16GB Intel [®] Optane TM memory) ^{1,2,*}	6	3.1	4.2	9	2666	N	Intel® UHD Graphics 630	Y	Y	65W
Intel® Core TM i5-8500 processor ¹	6	3.0	4.0	9	2666	N	Intel® UHD Graphics 630	Y	N	65W
Intel [®] Core TM i5+8500 processor (Core i5 and 16GB Intel [®] Optane TM memory) ^{1,2,*}	6	3.0	4.0	9	2666	N	Intel® UHD Graphics 630	Y	Y	65W
Intel® Core TM i3-8100 processor ¹	4	3.6	N/A	6	2400	N	Intel® UHD Graphics 630	N	N	65W
Intel® Pentium TM G5400 processor ¹	2	3.7	N/A	4	2400	Y	Intel® UHD Graphics 610	N	N	54W

¹Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance ²Intel[®] OptaneTM memory system acceleration does not replace or increase the DRAM in your system. *16GB Intel[®] OptaneTM memory Available Fall 2018

³The specifications shown in the Intel® Turbo Boost Technology column represent the maximum turbo frequency with one core activ Turbo boost stepping occurs in 100MHz increments. Processors that do not have turbo functionality are denoted as N/A. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See http://www.intel.com/technology/turboboost for more information.

⁴vPro. Some functionality of this technology, such as Intel® Active management technology and Intel® Virtualization technology, requires additional 3rd party software in order to run. Availability of future "virtual appliances"? applications for Intel vPro technolog is dependent on third-party software providers. Compatibility of this generation of Intel vPro technology-based hardware with futur "virtual appliances"? is vet to be determined.

NOTES

Integrated Intel[®] UHD graphics P630 is supported on the select Intel[®] Xeon E processors.

Intel[®] Xeon[®] E, Intel[®] CoreTM i3 and Intel[®] Pentium processors can support either ECC or non-ECC memory; Intel[®] Core i5/i7 processors only support non-ECC memory.

Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor_number/ for details.

NOTE: In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.

HP Z2 Tower G4 Workstation

Overview

Color	Black
Expansion Slots (see system board section for more details)	1 PCIe Gen3 x16 slot 1 PCIe Gen3 x4 slot /x16 connector 1 PCIe Gen3 x1 slot/x4 connector 1 PCIe Gen3 x1 slot/x4 connector 2 M.2 storage (PCIe Gen3 x4)* 1 M.2 Wlan (PCIe Gen3 x1+ intel CNVI)*
	NOTE: The PCIe Gen 3 x16 slot is meant for HP qualified cards, configured or after market. HP does not provide warranty support for 3rd party cards.
	* M.2 storage supports compatible devices at 80mm
Expansion Bays (see storage section for more details)	2 external Half Height 5.25" Bays 2 internal 3.5" Drive Bays
Front I/O	1 USB 3.0, 1 USB 3.0 Charging Data Port, 1 Headphone/Microphone. 1 USB3.1 Gen2 Type-C Charging Data Port (Optional), 1 SD Card Reader (Optional).
Internal I/O	1 USB 3.0 and 3 USB 2.0 ports available as 2 separate 2x10 (3.0 x1, 2.0 x1) and 2x5 (2.0 x2) header: supports one USB 3.0 Media Card Reader.
Rear I/O	2 DisplayPort TM (DP 1.2) outputs from Intel [®] UHD Graphics (available on specific processors only); 4 USB 3.0 ports, 2 USB 2.0 ports, 1 serial port (optional), 1 parallel port (optional), 2 PS/2 (optional), RJ-45 (LoM), 1 Flex IO port (3 rd DisplayPort TM /HDMI/VGA/2 nd 1GbE LAN/ USB-C 3.1 Gen2 Charging Data Port/Thunderbolt TM 3.0-Thunderbolt TM 3.0 PCIe card utilizes Flex IO option) , (1 Audio Line-in, and 1 Audio Line-out.
Interfaces Supported	SD Media Card Reader (optional) Type-C Battery Charging Port (optional)
Chassis Dimensions (H x W x D)	Standard minitower orientation: 356 mm x 169 mm x 435 mm (14.0 x 6.7 x 17.1 in)
Weight	Exact weights depend upon configuration:
	Minimum: 7.0 kg (15.43 lb)
	Typical*: 8.2 kg (18.03 lb) Maximum: 11.4 kg (25.18 lb)
	Supported Weight (desktop orientation): 35 kg (77 lb)
	Packaging (H x W x D): 599 x499 x 295 mm(23.58 x 19.65 x 11.6 in) Shipping Weight: 11.47 kg(25.26 lb)
Power Supply	* Typical weight when configured with 1 3.5" hard drives, 1 optical drive, 2 DIMMs and 1 NVIDIA® Quadro® P1000 graphics card 500W wide-ranging, active Power Factor Correction, 90 Efficient
	250W 85% Efficiency wide-ranging, active PFC Power Supply option.
Backup Devices	For a complete listing of compatible DAT tape drives, LTO tape drives and RDX Removable Disk Backup System offerings, please visit http://www.hp.com/go/connect
Chipset	Intel® C246 chipset
Memory	4 DIMM slots, supporting up to 64GB ECC/non-ECC, DDR4 2666 MT/s speed depending on the CPU selection.

Overview

HP Z2 Tower G4 Workstation

Supported Components

Processors		Factory Configured	Option Kit
	Intel® Xeon® processor E-2100 family ²		
	Intel [®] Xeon [®] processor E-2176G	Y	Ν
	Intel [®] Xeon [®] processor E-2174G	Y	Ν
	Intel [®] Xeon [®] processor E-2144G	Y	Ν
	Intel [®] Xeon [®] processor E-2136	Y	Ν
	Intel [®] Xeon [®] processor E-2126G	Y	Ν
	Intel [®] Xeon [®] processor E-2124G	Y	Ν
	Intel [®] Xeon [®] processor E-2104G	Y	Ν
	8th generation Intel® Core TM processor family ³		
	Intel® Core TM i7-8700K 3.7 2666 6C CPU	Y	Ν
	Intel® Core TM i7+8700K (Core i7 and 16GB Intel® Optane TM memory*) 3.7 2666 6C CPU	Y	Ν
	Intel® Core TM i7-8700 3.2 26666 6C CPU	Y	Ν
	Intel [®] Core TM i7+8700 (Core i7 and 16GB Intel [®] Optane TM memory*) 3.2 26666 6C CPU	Y	Ν
	Intel® Core TM i5-8600 3.1 2666 6C CPU	Y	Ν
	Intel [®] Core TM i5+8600 (Core i5 and 16GB Intel [®] Optane TM memory*) 3.1 2666 6C CPU	Y	Ν
	Intel® Core TM i5-8500 3.0 2666 6C CPU	Y	Ν
	Intel [®] Core TM i5+8500 (Core i5 and 16GB Intel [®] Optane TM memory*) 3.0 2666 6C CPU	Y	Ν
	8th generation Intel® Core TM i3/Pentium processor family ²		
	Intel® Core TM i3-8100 3.6 2400 4C CPU	Y	Ν
	Intel® Pentium® G5400 3.7 2400 2C CPU	Y	Ν

NOTE 1: Intel® Integrated P630 Graphics for select Xeon E processors supports workstation-specific graphics drivers for improved compatibility and performance on select professional applications, compared to Intel® UHD Graphics 630. NOTE 2: These processors support either ECC or non-ECC memory NOTE 3: These processors support only non-ECC memory

NOTE 4: Intel[®] OptaneTM memory system acceleration does not replace or increase the DRAM in your system.

*16GB Intel[®] OptaneTM memory Available Fall 2018

Supported Components

Monitors / Displays		Factory Configured	Option Kit	Option Kit Part Number
	HP Z Display Z27n G2 27-inch IPS LED Backlit Monitor		Y	1JS10AA
	HP Z Display Z24n G2 24-inch IPS LED Backlit Monitor		Y	1JS09AA
	HP Z Display Z24nf G2 23.8-inch IPS Backlit Monitor		Y	1JS07AA
	HP Z Display Z23n G2 23-inch IPS LED Backlit Monitor		Y	1JS06AA
	HP Z Display Z22n G2 21.5-inch IPS LED Backlit Monitor		Y	1JS05AA
	Supported by all Operating Systems available from HP Screen Size Diagonally Measured			

SATA Hard Drives		Factory Configured	Option Kit	Option Kit Part Number
	500GB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	LQ036AA
	1TB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	LQ037AA
	2TB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	QB576AA
	4TB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	K4T76AA
	6TB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	3DH90AA
	500GB SATA 7.2K SED SFF HDD	Y	Ν	(N/A as AMO)
	1TB SATA 7200 rpm 8GB 3.5" SSHD (hybrid)	Y	Y	M7S54AA
SATA Solid State Drives	HP 256GB SATA 6Gb/s SSD	Y	Y	A3D26AA
	HP 512GB SATA 6Gb/s SSD	Y	Y	D8F30AA
	HP 1TB SATA 6Gb/s SSD	Y	Y	F3C96AA
	HP 2TB SATA 6Gb/s SSD	Y	Y	Y6P08AA
	HP 256GB SATA 6Gb/s SED Opal 2 SSD	Y	Y	G7U67AA
	HP Enterprise Class 240GB SATA SSD	Y	Y	T3U07AA
	HP Enterprise Class 480GB SATA SSD	Y	Y	T3U08AA
	16GB Intel [®] Optane TM memory*,**	Y	Y	TDB

*Intel® OptaneTM memory (cache) is sold separately. Intel® OptaneTM memory system acceleration does not replace or increase the DRAM in your system. Available for HP commercial desktops and notebooks and for select HP workstations (HP Z240 Tower/SFF, Z2 Mini, ZBook Studio, 15 and 17 G5) and requires a SATA HDD, 7th Gen or higher Intel® CoreTM processor or Intel® Xeon® processor E3-1200 V6 product family or higher, BIOS version with Intel® OptaneTM supported, Windows 10 version 1703 or higher, M.2 type 2280-S1-B-M connector on a PCH Remapped PCIe Controller and Lanes in a x2 or x4 configuration with B-M keys that meet NVMeTM Spec 1.1, and an Intel® Rapid Storage Technology (Intel® RST) 15.5 driver.

**16GB Intel[®] OptaneTM memory Available Fall 2018

Supported Components

PCIe SSDs	PCIe SSDs for HP Workstations			
	HP Z Turbo Drv G2 1TB TLC PCIe SSD **	Y	Y	Y1T53AA
	HP Z Turbo Drv G2 256GB TLC PCIe SSD **	Y	Y	Note 1
	HP Z Turbo Drv G2 512GB TLC PCIe SSD **	Y	Y	Note 1
	Intel® 905p Series SSD (Opatane SSD)			
	Intel® Optane SSD 905p 280GB AiC*,***	Y	Y	2SC47AA
	Intel® Optane SSD 905p 480GB AiC*,***	Y	Y	2SC48AA
	* PCIe card installed in standard PCIe x4 slot ** Installed in native M.2 storage slot Z2 G4 *** Intel® Optane SSD Available Fall 2018			

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows 10) of system disk is reserved for system recovery software.

NOTE: The HP Z2 Tower G4 Workstation is capable of configuring up to 2 Z Turbo Drives. By default, the Z Turbo Drive configured will be installed in the M.2 storage slot on the system's motherboard.

Hard Drive Controllers		Factory Configured	Option Kit
	Integrated SATA Controller (Z2 G4)		
	Integrated SATA Controller, RAID 0,1 supported: 4x 6 Gb/s ports	Y	Ν
	Factory integrated RAID on motherboard for SATA drives		
	RAID 0 Data Configuration	Y	Ν
	RAID 1 Data Configuration	Y	Ν
	Factory integrated RAID on motherboard for Z Turbo Drive		
	RAID 0 Boot or Data Configuration	Y	Ν
	RAID 1 Boot or Data Configuration	Y	Ν

NOTE: SATA hardware RAID is not supported on Linux[®] systems. The Linux[®] kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. All drives must be identical in type and capacity. Boot volume/RAID array must be less than 2 TB **NOTE 1:** Requires identical drives (speeds, capacity, and interface).

Graphics		Factory		Option Kit Part	Supported	
		Configured	Option Kit	Number	# of cards	Mixed?
	Integrated Intel® UHD Graphics	Media Accelerator	s (Z2 G4)			
	Intel [®] UHD Graphics P630	Y	Ν		1	
	Intel [®] UHD Graphics 630	Y	Ν		1	
	Intel [®] UHD Graphics 610	Y	Ν		1	

Graphics Cable Adapters

HP Z2 Tower G4 Workstation

QuickSpecs

Supported Components

p.	Shenes				
	HP DisplayPort TM to Dual Link DVI Adapter	Ν	Y	NR078AA	1
	HP DisplayPort TM To DVI-D Adapter (4-Pack)	Ν	Ν		1
	HP DisplayPort [™] To DVI-D Adapter (2-Pack)	Y	Ν		1
	HP DisplayPort [™] To DVI-D Adapter	Y	Y	FH973AA	1
	HP DisplayPort [™] To VGA Adapter	Y	Y	AS615AA	1
	HP Display to HDMI Adapter	Ν	Y		
	HP miniDP to DP Adapter	Ν	Y		
	HP USB-C to VGA Adapter	Ν	Y		
	HP USB-C to HDMI Adapter	Ν	Y		
	HP USB-C to DP Adapter	Ν	Y		
	Entry 3D				
	Radeon [™] Pro WX3100 4GB Graphics	Y	Y	2TF08AA	2
	NVIDIA® Quadro® P400 2GB Graphics	Y	Y	1ME43AA	2
	NVIDIA® Quadro® P620 2GB Graphics	Y	Y	3ME25AA	2
	Mid-range 3D				
	Radeon [™] Pro WX4100 4GB 1st GFX Graphics	Ν	Y	ZOB15AA	1
	NVIDIA® Quadro® P1000 4GB Graphics	Y	Y	1ME01AA	2
	NVIDIA® Quadro® P2000 5GB Graphics	Y	Y	1ME41AA	1
	High End 3D				
	Radeon TM Pro WX7100 8GB Graphics*	Y	Y	ZOB14AA	1
	NVIDIA® Quadro® P4000 8GB Graphics	Y	Y	1ME40AA	1
	NVIDIA® Quadro® P5000 16GB Graphics	Y	Y	1ME40AA	1

* Requires 500W PSU. Not supported with 250W PSU.

NOTE 1: Intermixing integrated Intel[®] UHD graphics and discrete graphics cards in order to drive more than three displays can be enabled using the Computer (F10) Setup Utility. However, HP recommends using only discrete graphics when four or more displays are required to be supported.

Supported Components

Memory

DDR4-2666 ECC Unbuffered DIMMs - CTO

8GB DDR4-2666 ECC (1x8GB) RAM 16GB DDR4-2666 ECC (2x8GB) RAM 32GB DDR4-2666 ECC (4x8GB) RAM 32GB DDR4-2666 ECC (2x16GB) RAM 64GB DDR4-2666 ECC (4x16GB) RAM

DDR4-2666 non-ECC Unbuffered DIMMs - CTO

4GB DDR4-2666 nECC (1x4GB) RAM 8GB DDR4-2666 nECC (2x4GB) RAM 8GB DDR4-2666 nECC (1x8GB) RAM 16GB DDR4-2666 nECC (2x8GB) RAM 32GB DDR4-2666 nECC (2x16GB) RAM 32GB DDR4-2666 nECC (4x8GB) RAM 64GB DDR4-2666 nECC (4x16GB) RAM

NOTES:

Intel[®] Xeon E, Intel[®] CoreTM i3 and Intel[®] Pentium processors can support either ECC or non-ECC memory; Intel[®] CoreTM i5/i7 processors only support non-ECC memory.

Two channels of DDR4 memory are supported. To realize full performance at least one DIMM must be inserted into each channel.

Max transfer rates up to 2666 MT/s

АМО	Option Kit Part Number
DDR4-2666 ECC Unbuffered DIMMs - AMO	
HP 8GB (1x8GB) DDR4-2666 ECC Unbuffered RAM	3TQ39AA
HP 16GB (1x16GB) DDR4-2666 ECC Unbuffered RAM	3TQ40AA
DDR4-2666 non-ECC Unbuffered DIMMs - AMO	
HP 4GB (1x4GB) DDR4-2666 nECC Unbuffered RAM	3TQ31AA
HP 8GB (1x8GB) DDR4-2666 nECC Unbuffered RAM	3PL81AA
16GB (1x16GB) DDR4-2666 nECC Unbuffered RAM	3PL82AA
NOTE: Only unbuffered DDR4 DIMMs are supported.	locked If a 2400 MHz capable (

The CPUs determine the speed at which the memory is clocked. If a 2400 MHz capable CPU is used in the system, the maximum speed the memory will run at is 2400 MHz regardless of the specified speed of the memory.

Multimedia and Audio Devices		Factory Configured	Option Kit	Option Kit Part Number
	Integrated Conexant CX20632 5.1 HDA codec	Y	Ν	

HP Z2 Tower G4 Workstation

Supported Components

Optical and Removable Storage		Factory Configured	Option Kit	Option Kit Part Number
	HP 9.5mm Slim DVD Writer	Y	Y	K3R64AA
	HP 9.5mm Slim DVD-ROM Drive	Y	Y	K3R63AA
	HP 9.5mm Slim BDXL Blu-Ray Writer	Y	Y	K3R65AA
	HP SD Media Card Reader	Y	Y	
	HDD Frame/Carriers			
	HP DX175 Removable HDD Carrier	Ν	Y	1ZX72AA
	HP DX175 Removable HDD Frame/Carrier	Ν	Y	1ZX71AA

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive ma not be compatible with many existing single-layer DVD drives and players. With Blu-ray, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

Controller Cards		Factory Configured	Option Kit	Option Kit Part Number
	HP Thunderbolt [™] 3 PCIe 3-port I/O Card	Y	Y	4CX35AA
	NOTE 1: Utilizes Flex IO port connection for flex port			

Networking and Communications		Factory Configured	Option Kit	Option Kit Part Number
	Integrated Intel® I219LM PCIe GbE Controller (Intel® vPro TM with Intel® AMT 12.0)	Y	Ν	
	Intel [®] X710-DA2 2-Port 10GbE SFP+ NIC	Y	Y	1QL47AA
	HP 10GbE SFP+ SR Transceiver	Y	Y	C3N53AA
	Intel [®] X550-T2 2-Port 10GbE NIC	Y	Y	1QL46AA
	Intel® 9560 802.11 a/b/g/n/ac with Bluetooth® 5 M.2	Y	Ν	
	Intel [®] I350-T2 2-Port 1GbE ⁽³⁾ NIC	Y	Y	V4A91AA
	Intel [®] I350-T4 4-Port 1GbE ⁽³⁾ NIC	Y	Y	W8X25AA
	Aquantia AQN-108 1-Port 5GbE NIC	Y	Y	1PM63AA
	NOTE 1 : The integrated network connection is required to suppor NOTE 2 : If AMT is provisioned, then network teaming with the int			

NOTE 3: "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does no connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Supported Components

Racking and Physical Security		Factory Configured	Option Kit	Option Kit Part Number
	Kensington Lock	Ν	Y	
	HP Z2 Mini Sleeve	Ν	Y	3RW68AA
	HP Z4/6 Depth Adjustable Fixed Rail Rack Kit	Ν	Y	2HW42AA
	HP Solenoid Lock and Hood (TWR) Sensor	Y	Y	E0X96AA
	HP Business PC Security Lock Kit	Ν	Y	PV606AA
	HP UltraSlim Cable Lock Kit	Ν	Y	T1A62AA

Input Devices		Factory Configured	Option Kit	Option Kit Part Number
	HP USB Optical Mouse	Y	Y	QY777AA
	HP PS/2 Mouse	Ν	Y	QY775AA
	HP USB Hardened Mouse	Y	Y	P1N77AA
	HP USB Premium Mouse	Y	Y	
	HP Premium Wireless Mouse	Y	Y	
	SpaceMouse Pro USB 3D Input Device	Ν	Y	
	3Dconnexion CADMouse	Ν	Y	M5C35AA
	HP USB Business Slim CCID SmartCard Keyboard	Y	Y	
	HP USB Business Slim Keyboard	Y	Y	N3R87AA
	HP PS/2 Business Slim Keyboard HP USB Premium Keyboard	Ν	Y	
		Y	Y	N3R86AA
	HP Premium Wireless Keyboard	Y	Y	
	HP Wireless Business Slim Keyboard & Mouse	Y	Y	

Other Hardware		Factory Configured	Option Kit	Option Kit Part Number
	HP Power Cord Kit	Ν	Y	DM293A
	HP Workstation Mouse Pad (Japan only)	Y	Ν	
	HP Serial Port Adapter	Y	Y	1VD82AA
	HP Serial + PS/2 Adapter	Y	Y	
	HP ENERGY STAR [®] Certified Configuration	Y	Ν	
	HP Internal USB Port Kit	Ν	Y	EM165AA
	HP eSATA PCI Cable Kit	Y	Y	FH966AA
	HP Z2 Tower G4 Bezel w/ Dust Filter option	Ν	Y	4KY89AA
	HP PCIe x1 Parallel Port Card	Ν	Y	N1M40AA
	Z2 Tower G4 Dust Filter (filter only)	Ν	Y	3TQ24AA
	HP Z2 G4 TWR Front Card Guide Kit	Y	Y	4KY82AA
Flex Module (Rear IO)		Factory Configured	Option Kit	
	HP Flex IO module (VGA)	Y	Ν	3TK80AA
	HP Flex IO module (HDMI)	Y	Ν	3TK74AA
	HP Flex IO module (DP)	Y	Ν	3TK72AA
	HP Flex IO module (USB-C)	Y	Ν	4KY84AA
	HP Flex IO module (1 Gbe LAN)	Y	Ν	3TQ26AA

Supported Components

Software		Factory Configured	Option Kit	Support Notes
	HP Performance Advisor	Y	Ν	Note 1
	HP Remote Graphics Software (RGS) 7.x	Y	Ν	
	HP PC Hardware Diagnostics UEFI	Y	Ν	Note 2
	NOTE 1 : Supports, and preinstalled with Windows 10 only. Als http://www.hp.com/go/performanceadvisor NOTE 2 : Windows OS only	o available as a	free download	from
Operating Systems	Windows 10			
	Windows 10 Pro 64			
	Windows 10 Pro (National Academic License)			
	Windows 10 Pro for Workstations - HP recommends Windows			
	Red Hat [®] Enterprise Linux [®] (RHEL) Workstation - Paper License	e (1yr)		
	NOTE : For detailed OS/hardware support information for Linux http://www.hp.com/support/linux_hardware_matrix	, see:		
	http://www.microsoft.com/windows/windows-7/			
HP BIOS	Key features of the HP BIOS include:			
	 Deployment and manageability - HP BIOS p help integrate the HP Z2 G4 Workstation into remote recovery, remote configuration, remo support for 14 languages. 	o the enterpri	se, such as I	PXE,
	 Network firmware updates - Update your BIO BIOS version hosted on an Enterprise netwo 		oud or standa	ardize on a
	 Stability - HP BIOS supports the HP stable p critical BIOS changes to the factory and adv 			
	 UEFI specification version 2.6 			
	 Absolute Persistence agent - For tracking ar select countries, separate software and pure 			
	 Thermal and power management - The HP I and power management technologies so co managed for high reliability and to assist in c computer in any enterprise environment. 	mponent tem	peratures a	е
	 Acoustic performance - Industry leading according conditions. 	oustic emissio	ons across th	ne range of
	 Serviceability - HP BIOS provides diagnostic 	and detailed	l service info	rmation.
	 Upgrades and recovery - HP BIOS provides Workstation computers, including BIOS upd Firmware Update and Recovery), HP Client addition, the HP BIOS Configuration Utility e 	lates from wit Manager, and	hin Windows d fail-safe rec	s (HP covery. In

Supported Components

within Windows while the Replicated Setup feature provides the same capability within BIOS (F10) Setup. The BIOS Configuration Utility is available from the HP support website.

• HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.

Additional HP BIOS Features:

- Power-On password Helps prevent an unauthorized user from powering on the system.
- Administrator password Also known as the BIOS Setup password, this helps prevent unauthorized changes to the system configuration. If the administrator password is not known, the BIOS cannot be updated and changes cannot be made to BIOS settings using BIOS Setup or under the OS.
- S5 Maximum Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 0.5W in S5 (when turned off). When S5 Maximum Power Savings feature is enabled below features are turned off: -Power to expansion connectors / slots
 Wake events other than power buttons (such as wake on LAN)
 - -USB charging ports

HP Sure Start Gen4 Start

- BIOS Integrity checking Sure Start protection ensures that only trusted BIOS code is executed and not rootkits, viruses and malware. Verification is done upon boot up, shutdown and while the system is on.
- Sure Start is set by default to automatically repair the BIOS if corrupted or compromised but is policy driven for better manageability. Start is set by default to automatically repair the BIOS if corrupted or compromised but is policy driven for better manageability.
- Protecting beyond BIOS Integrity checking and repair is extended to other data that should be protected such as network configuration parameters, platform specific information (i.e. system IDs), secure boot credentials, and other code the system needs to boot.
- Audit enabled System Audit via Sure Start Event Logs capture data such as incident, repair date and time for troubleshooting and investigating

HP Sure Start Gen4 is available on HP Workstation products equipped with Intel® 8th generation processors. HP Sure Start Gen4 is available on HP Workstation products equipped with Intel® 8th generation processors.

SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

BIOS HP BIOSphere Gen4¹⁷ HP DriveLock & Automatic DriveLock BIOS Update via Network Master Boot Record Security Power On Authentication Authentication Secure Erase ¹⁸

Supported Components

Absolute Persistence Module¹⁹ Pre-boot Authentication HP Wireless Wakeup

Software HP Hotkey Support - CMIT

Manageability Features HP Driver Packs²² HP System Software Manager (SSM) HP BIOS Config Utility (BCU) HP Client Catalog HP Manageability Integration Kit Gen2²³

Client Security Software HP Client Security Suite Gen4²⁵ including: HP Security Manager²⁶ (including Credential Manager, HP Password Manager, HP Spare Key) HP Device Access Manager HP Power On Authentication Authentication Microsoft Defender²⁷

Security Management Secure Erase¹⁸ TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified)³² SATA port disablement (viaBIOS) RAID configurations³³ Serial, USB enable/disable (viaBIOS) Power-on password (viaBIOS) Setup password (viaBIOS) Setup password (viaBIOS) Support for chassis padlocks and cable lock devices Integrated hood sensor HP Sure Click³⁷ HP Sure Start Gen4³⁰ HP Sure Run³⁵ HP Sure Recover³⁶

17. HP BIOSphere Gen4 features may vary depending on the Workstation platform and configurations requires 8th Gen Intel® processors.

18. Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88. Supported on Workstation platforms with BIOS version F.O3 or higher.

19. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit:

http://www.absolute.com/company/legal/agreements/ computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software. Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

22. HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.

23. HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.html 25. HP Client Security Suite Gen 4 requires Windows and Intel[®] or AMD 8th generation processors.

26. HP Password Manager requires Internet Explorer or Chrome or FireFox. Some websites and applications may not be supported. User may need to enable or allow the add-on / extension in the internet browser.

27. Microsoft Defender Opt in and internet connection required for updates.

30. HP Sure Start Gen4 is available on HP Workstation products equipped with Intel® 8th generation processors

32. Firmware TPM is version 7.6. Hardware TPM is v2.0.

33. RAID configuration is optional and does require a second hard drive.

35. HP Sure Run is available on HP Workstation products equipped with 8th generation Intel® or AMD® processors.

36. HP Sure Recover is available on HP Workstations with 8th generation Intel® or AMD processors and requires an open, wired

Supported Components

network connection. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data.

38. HP Sure Click is available on select HP Workstation platforms and supports Microsoft[®] Internet Explorer and ChromiumTM. Check http://h20195.www2.hp.com/v2/GetDocument.aspx?docname=4AA7-0922ENW for all compatible platforms as they become available

System Technical Specifications

System Board

System Duaru		
System Board Form Factor	ATX 24.89 x 24.38 mm (9.8 x 9.6 inches)	
Processor Socket	Single LGA-1151	
CPU Bus Speed	DMI	
Chipset	Intel® PCH C246	
Memory Expansion Slots	4 DDR4 memory slots	
Memory Type Supported	DDR4, UDIMM (Unbuffered), ECC& non-EC	C
Memory Modes	Non-Interleaved for single channel. Interle	eaved when both channels are populated.
Memory Speed Supported	2666MT/s DDR4	
Memory Protection	ECC available on data	
Maximum Memory	64GB	
Memory Configuration (Supported)	4GB, 8GB and 16GB non-ECC/4GB, 8GB and ECC and non-ECC memory DIMMs cannot	d 16GB ECC unbuffered DIMMs are supported. be mixed on the same system.
		ume 64-bit operating systems, such as Genuine Windows® 10 . 32-bit Windows Operating Systems support up to 4 GB.
PCI Express Connectors	 1 PCI Express Gen3 slot x4 mechani 1 PCI Express Gen3 slot x4 mechani 	nical/ x16 electrical (full height, full length) ical/ x1 electrical (full height, full length) ical/ x4 -x1 electrical (full height, full length) nical/ x4 electrical (full height, full length)
	In the PCIe Gen3 (x16 electrical/x16 mech Note1: M.2 storage supports compatible	anical) slot, it intent to supported HP certified added in card. devices up to 110mm
Supported Drive Interfaces	SATA	Integrated (4) Serial ATA interfaces (6Gb/s SATA). One port can optionally be used for eSATA. RAID 0 and 1 supported. Factory integrated RAID is Microsoft Windows only. RAID 5 is supported by Software XOR.
	Serial Attached SCSI	None
	Integrated RAID	NOTE: Requires identical hard drives (speeds, capacity, interface)
	Integrated Graphics	Intel® UHD Graphics 630 (on Core i3/i5/i7-8xxx processors); Intel® Integrated Graphics P630 for Xeon processors
		Based on Unified Memory Architecture (UMA) - a region of system memory is reserved and dedicated to the graphics display.
		Support for Microsoft DirectX 12, OpenGL 4.4 and OpenCL 2.0 on Intel® UHD Graphics P630;
		3 DP 1.2 graphics ports integrated in motherboard; Supports up to three simultaneous displays across DP & DVI-D outputs.
		Max. resolution supported on DP 1.2 ports: 3840x2160 @60Hz
	Network Controller	Integrated Ethernet PHY Connection I219LM. Management capabilities: WOL, PXE 2.1 and AMT 12
	External SATA (eSATA)	1 port eSATA capable (SATA 3)
	IDE connector	No

System Technical Specifications

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	Floppy connector	No
	Serial	1 internal header (requires optional Serial Port Adapter Kit)
	2nd Serial	Yes
	HD Integrated Audio	Yes
USB Connector(s)	Front	1 USB-A 3.0, 1 USB-A 3.0 Charging Data Port and 1 USB-C 3.1 Gen2 Charging Data Port (Optional).
	Rear	4 USB-A 3.0, 2 USB-A 2.0, and 1 USB-C 3.1 Gen2 Charging Data Port (Optional via Flex module).
	Internal	1 USB 3.0 and 3 USB 2.0 ports available as 2 separate 2x6(3.0 x1,2.0 x1) and 1x6(2.0 x1) headers: one USB 3.0 SD Card Reader.
HD Integrated Audio	Yes	
Flash ROM	Yes	
CPU Fan Header	Yes	
Chassis Fan Header	1 Rear System Chassis Fan Header	
Front Control Panel/Speaker Header	Yes	
CMOS Battery Holder - Lithium	Yes	
Integrated Trusted	Integrated TPM 2.0	
Platform Module	The TPM module disabled where restricte	ed by law, i.e. Russia.
Power Supply Headers	Yes	
Power Switch, Power LED & Hard Drive LED Header	Yes	
Clear Password Jumper	Yes	
Keyboard/Mouse	USB or PS/2 (option)	
Power Supply		

System Configurations				
Z2 G4 TWR	Processor Info	1x Intel® Core TM i3-6100 3.7 3MB 51W CPU		
Configuration #1 (TBD)	Memory Info 4GB (1x 4GB) 2133 MHz DDR4 non-ECC			
	Graphics Info	Intel® UHD Integrated Graphics 630		
	Disks/Optical/Floppy	1x SATA 500 GB 7.2k rpm/ 1x 9.5mm Slim ODD		
PSU 280W 90%		280W 90%		
	Other			

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Energy Consumption		115	VAC	230	VAC	100	VAC
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows long Idle (S0)	TE	3D	TE	3D	TE	3D
	Windows short Idle (S0)	Т	3D	TE	3D	TE	3D
	Windows Busy Typ (SO)	Т	3D	TE	3D	TE	3D
	Windows Busy Max (SO)	Т	3D	TE	3D	TE	3D
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD
	Zero Power Mode (EuP)	Т	3D	TE	3D	TE	3D
Heat Dissipation		115	VAC	230 VAC 100 VAC		VAC	
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (SO)	Т	3D	TE	3D	TE	3D
	Windows short Idle (SO)	Т	3D	TE	3D	TE	3D
	Windows Busy Typ (SO)	Т	3D	TE	3D	TE	3D
	Windows Busy Max (S0)	Т	3D	TBD		TE	3D
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD
	Zero Power Mode (EuP)	Т	BD	TE	BD	TE	3D

Configuration #2 (TBD)	Processor Info	1x Intel® Core TM i5-6500 3.2 6MB 65W CPU
	Memory Info	8GB (2x 4GB) 2133 MHz DDR4 ECC
ENERGY STAR [®] CERTIFIED	Graphics Info	1x NVIDIA® Quadro® K2200 1GB Graphics
	Disks/Optical/Floppy	2x SATA 1 TB 7.2k rpm/ 1x9.5mm Slim ODD
	PSU	400W 92%
	Other	

Energy Consumption		115 VAC		230	VAC	100 VAC		
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows long Idle (S0)	TBD		TBD		TBD		
	Windows short Idle (S0)	TE	3D	TBD		TE	3D	
	Windows Busy Typ (SO)	TE	3D	TE	TBD		3D	
	Windows Busy Max (SO)	TE	3D	TE	3D	TE	3D	
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD	
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD	
	Zero Power Mode (EuP)		TBD		TBD		TBD	
Heat Dissipation		115 VAC		230 VAC		100 VAC		
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows Idle (SO)	TBD		ТЕ	3D	TBD		
	Windows short Idle (SO)	TBD		TBD		TBD		
	Windows Busy Typ (SO) Windows Busy Max (SO)		TBD		TBD		TBD	
			3D	TE	3D	TE	3D	
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD	
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD	
Zero Power Mode (EuP)		TE	3D	TE	3D	TE	3D	

Z2 G4 TWR	Processor Info	1x Intel® Xe	eon® E3-128	30v5 3.7 8MB	3 80W CPU		
Configuration #3 (TBD)	Memory Info	64GB (4x16	6GB) 2133 M	1Hz DDR4 E	CC		
	Graphics Info	1x NVIDIA®	Quadro® N	/14000 8GB (Graphics		
	Disks/Optical/Floppy	2x 512GB Z	Z Turbo Drive	e G2 PCIe S	SDs / 1x9.5r	nm Slim OD	D
	PSU	400W 92%	400W 92%				
	Other						
Energy Consumption		115	VAC	230	VAC	100	VAC
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows long Idle (S0)	Т	3D	Т	3D	TE	BD
	Windows short Idle (S0)	Т	3D	Т	3D	TE	3D
	Windows Busy Typ (SO)	Т	3D	T	3D	TE	3D
	Windows Busy Max (SO)	TBD		TBD		TBD	
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD
	Zero Power Mode (EuP)	T	3D	Т	3D	TE	3D
Heat Dissipation		115 VAC		230	VAC	100 VAC	
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (SO)	TI	3D	TBD		TBD	
	Windows short Idle (SO)	TI	3D	TBD		TBD	
	Windows Busy Typ (SO)	ТІ	3D	TBD		TBD	
	Windows Busy Max (SO)	ТІ	3D	Т	BD	TE	BD
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD
	Zero Power Mode (EuP)	<u> Ti</u>	BD	<u> </u>	3D	TE TE	BD
	400W Wide Ranging, Active			Power Suppl	y option avai	ilable in some	e countries.
	The HP Z2 Tower G4 Works	station 400W	PSU Efficien	cy Report can	be found at	this link:	

Operating Voltage Range	90-269 VAC
Rated Voltage Range	100-240 VAC
Rated Line Frequency	50-60 Hz
Operating Line Frequency Range	47-66 Hz
Rated Input Current	6A @ 100-240V
Heat Dissipation	Typical: 444 btu/hr (112 kcal/hr) Maximum: 1484 btu/hr (374 kcal/hr)
Power Supply Fan	80mm x 80mm x 25mm 4-wire PWM
ENERGY STAR [®] certified (Config Dependent)	Yes
CECP Compliant @ 220V	Yes
FEMP Standby Power Compliant	Yes, with Wake-on-LAN disabled: <2W in S5- Power Off
Built-in Self Test (BIST) LED	Yes

Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V)	Yes
Hood Lock Header	Yes
ErP Lot 6- Tier 1	Yes
Compliance @ 230V (<1W	
in S5- Power Off)	
ErP Lot 6- Tier 2	Yes
Compliance @ 230V (<0.5W in S5- Power Off)	

Declared Noise Emissions (Entry-level, Mid-level, and High-end configurations; tested on floor)			
System Configuration (Entry level)	Processor Info	Intel® Core TM i7-8700 3.2 26666 6C CPU	
	Memory Info	64GB DDR4-2666 nECC (4x16GB) RAM	
	Graphics Info	Intel® UHD	
	Disks/Optical	1 TB SATA 6Gb/s SSD / No Optical	

Declared Noise Emissions (in accordance with ISO		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
7779 and ISO 9296)	Idle	3.2	13
	Hard drive Operating (random reads)	3.3	13

System Configuration (Mid-level)	Processor Info	Intel® Xeon® processor E-2136
	Memory Info	64GB DDR4-2666 nECC (4x16GB) RAM
	Graphics Info	NVIDIA® Quadro® P4000 8GB
	Disks/Optical	2 x 2TB SATA 7200 rpm 6Gb/s 3.5" HDD / No Optical

Declared Noise Emissions (in accordance with ISO		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
7779 and ISO 9296)	Idle	3.6	18
	Hard drive Operating (random reads)	3.8	22

System Configuration	Processor Info	Intel® Core TM i7-8700K 3.7 2666 6C CPU
(High-end) Memory Info		64GB DDR4-2666 nECC (4x16GB) RAM
Graphics Info NVIDIA® Quadro® P4000 8GB		NVIDIA® Quadro® P4000 8GB
	Disks/Optical	2 x 2TB SATA 7200 rpm 6Gb/s 3.5" HDD / No Optical

Declared Noise Emissions (in accordance with ISO		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
7779 and ISO 9296)	Idle	3.5	18
	Hard drive Operating (random reads)	3.7	21

Environmental Requirements

System Technical Specifications

l	Temperature	Operating: 5° to 35° C (40° to 95° F) Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation Non-operating: -40° to 60° C (-40° to 140° F) Maximum rate of change: 10°C/hr
	Humidity	Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb
	Maximum Altitude	Operating (with Rotational Hard Drives): 3,048 m (10,000 feet) Operating (with only Solid-State Drives): 5,000 m (16,404 feet) Non-operating: 12,192 m (40,000 feet) Maximum operating temperature is reduced as altitude increases. See Temperature for details.
	Shock (non-repetitive)	Operating ½-sine: 40g, 2-3ms (~62 cm/sec) Non-operating ½-sine: 160 cm/s, 2-3 ms (~105 g) Non-operating square: 422 cm/s, 20 g
	Vibration	Operating random: 0.5 g (rms), 5-300 Hz, up to 0.0025 g²/Hz Non-operating random: 2.0 g (rms), 5-500 Hz, up to 0.0150 g²/Hz

Physical Security and Serviceability

Access Panel	Tool-less Includes system board and memory information
Optical Drive	Tool-less, except for Screw-In carrier
Hard Drives	Tool-less
Expansion Cards	Tool-less
Processor Socket	Tool-less, except for the processor heatsink
Blue User Touch Points	Yes, on tool-less internal chassis mechanisms
Color-coordinated Cables	
and Connectors	
Memory	Tool-less
System Board	Screw-In
Dual Color Power and HD	Yes
LED on Front of Computer	
Configuration Record SW	Yes
Over-Temp Warning on Screen	Yes
Restore CD/DVD Set	Consists of an operating system DVD (OSDVD) and a driver DVD (DRDVD). OSDVD restores the original operating system. DRDVD will provide all drivers for the system. The DRDVD may also contain application
	that originally shipped with the system for optional installation. Applications can also be obtained from HP.com. OSDVD and DRDVD are orderable with the system and available from HP Support.
Dual Function Front Power Switch	
	HP.com. OSDVD and DRDVD are orderable with the system and available from HP Support.
Switch	HP.com. OSDVD and DRDVD are orderable with the system and available from HP Support. r Yes, causes a fail-safe power off when held for 4 seconds Yes (optional): Locks side cover and secures chassis from theft
Switch Padlock Support	HP.com. OSDVD and DRDVD are orderable with the system and available from HP Support. Yes, causes a fail-safe power off when held for 4 seconds Yes (optional): Locks side cover and secures chassis from theft 0.22-in diameter padlock loop at rear of system Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft

Rear Port Control Cover	Yes, locks rear IO cables to prevent cable theft		
Serial, USB, Audio,	Yes, enables or disables serial, USB, audio, and network ports		
Network, Enable/Disable			
Port Control			
Removable Media Write/Boot Control	Yes, prevents ability to boot from removable media on supported devices (and can disable writes to media		
Power-On Password	Yes, prevents an unauthorized person from booting up the workstation		
Setup Password	Yes, prevents an unauthorized person from changing the workstation configuration		
3.3V Aux Power LED on System PCA	Yes		
NIC LEDs (integrated) (Green & Amber)	Yes		
CPUs and Heatsinks	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less		
Power Supply Diagnostic LED	Yes		
Front Power Button	Yes, ACPI multi-function		
Front Power LED	Yes, white (normal), red (fault)		
Front Hard Drive Activity LED	Yes, white		
Front ODD Activity LED	Yes		
Internal Speaker	Yes		
System/Emergency ROM Flash Recovery	Recovers corrupted system BIOS.		
Cooling Solutions	Air cooled forced convection		
Power Supply Fans	92mm x 92mm x 25mm 4-wire PWM (non-serviceable)		
CPU Heatsink Fan	Mainstream (<=65W): 92 mm x 92 mm x 52.5 mm Performance (<=95W): 94mm x 100.2mm x 110mm		
Chassis Fan	92mm x 92mm x 25mm 4-wire PWM (non-serviceable)		
Memory Heatsink Fan	Νο		
HP PC Hardware	HP PC Hardware Diagnostics (UEFI) enables hardware level testing outside the operating system on many		
Diagnostics UEFI	components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support.		
Access Panel Key Lock	Νο		
ACPI-Ready Hardware	Advanced Configuration and Power Management Interface (ACPI).		
	 Allows the system to wake from a low power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. 		
Integrated Chassis Handles	Rear Recessed Handle; optional Optical Bay Front Handle available.		
Power Supply	Requires T15 Torx or flat blade screwdriver		
PCI Card Retention	Yes, rear (all), middle (optional), front (full-length cards with extender)		
Flash ROM	Yes		
Diagnostic Power Switch LED on board	Yes		
Clear Password Jumper	Yes		
Clear CMOS Button	Yes		
CMOS Battery Holder	Yes		
DIMM Connectors	Yes		

System Technical Specifications

Social and Environmental Responsibility

Eco-Label Certifications &This product is low halogen except for power cords, cables and peripherals. Service parts obtained afterDeclarationspurchase may not be Low Halogen:

Batteries	 ENERGY STAR® (energy-saving features available on selected configurations-Windows only) US Federal Energy Management Program (FEMP) China Energy Conservation Program IT ECO declaration The battery in this product complies with EU Directive 2006/66/EC Battery size: CR2032 (coin cell) Battery type: Lithium Metal
	The battery in this product does not contain:
	 Mercury greater than 5ppm by weight Cadmium greater than 10ppm by weight Lead greater than 40ppm by weight
Restricted Material Usage	This product meets the material restrictions specified in HP's General Specification for the Environment. http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf HP Inc. is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis.
Low Halogen Statement	This product is low halogen except for power cords, cables and peripherals, as well as the following customer-configurable internal components: Creative Recon3D PCIe Audio Card is not Low Halogen. Servic parts obtained after purchase may not be Low Halogen.
End-of-Life Management and Recycling	HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life.
HP Inc. Corporate Environmental Information	For more information about HP's commitment to the environment: Living Progress Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html
	Eco-label certifications http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html
	ISO 14001 certificates:
Additional Information	 http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
	 Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043. This product is >90% recycle-able when properly disposed of at end of life EPEAT Gold registered in the United States. See http://www.epeat.net for registration status in you country. EPEAT® registered where applicable. EPEAT registration varies by country. See http://www.epeat.net for registered on HP 's 3rd party option store for solar energy accessory at http://www.hp.com/go/options
Packaging	HP Workstation product packaging meets the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/society/gen_specifications.html
	 Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment Does not contain ozone-depleting substances (ODS) Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of 100

System Technical Specifications

ppm sum total for all heavy metals listed
 Maximizes the use of post-consumer recycled content materials in packaging materials
 All packaging material is recyclable
 All packaging material is designed for ease of disassembly
 Reduced size and weight of packages to improve transportation fuel efficiency
 Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards formatting

Packaging Materials
Internal
Cushions made from fabricated recycled expanded-polyethylene (EPE) or recycled expanded-polypropylene (EPP). May also be made from recycled molded paper-pulp (MPP).
External
Carton made from corrugated fiberboard with at least 35% recycled content.

Manageability

Intel [®] Active Management Technology (AMT) v12	An advanced set of remote management features and functionality which provides network administrator the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 12 includes the following advanced management functions: • Support for configuration of Intel AMT 12.0 new capabilities
	 No reset after provisioning Support changes to BIOS table 130 Support for Microsoft Windows Server 2012 R2 Support for New Microsoft SQL Server Versions including Standard and Enterprise editions Support for Intel SSD Prop 2500 Series Support for Intel Enterprise Digital Fence The Platform Discovery Utility can now discover these additional Intel products:
	 Intel SSD Pro 2500 Series; Enterprise Digital Fence Intel Identity Protection Technology with One Time Password; Public Key Infrastructure; Multi Factc Authentication Intel Identity Protection Technology with Intel WiGig New Profile Editor and Profile Editor Plugin Interface New Required Permissions for Solutions Framework
Intel® vPro™ Technology	The HP Z2 Tower G4 Workstations support Intel® vPro™ technology when purchased with a vPro™ technology capable CPU: Intel® Xeon® E-2100 processor family or 8 th Generation Intel® Core™ i5/i7 processors with Intel® VT-d/VT-x and Intel® TXT technology
HP Image Assistant	Visit: http://ftp.hp.com/pub/caps-softpaq/cmit/HPIA.html
System Software Manager	r Visit: http://www.hp.com/go/ssm
Service, Support, and Warranty	 Program to proactively communicate Product Change Notifications (PCNs) and CustomerAdvisories by email to customers, based on a user-defined profile. PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition. Customer Advisories provide concise, effective problem resolution, greatly reducing the need to cal technical support

Stable & Consistent Offerings

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chose set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section. HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers—no special programs, no additional cost—no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

Processors	Product #	Offering Intel® Xeon® E-2124 3.4 8M GT2 4C	
		Intel [®] Xeon [®] E-2144 3.6 8M GT2 4C	
Hard Drives	Product #	Offering	
naru Drives	Flouuct #	512GB M.2 TLC 1st SSD	
		1TB 7200 RPM SATA 1st HDD	
Graphics	Product #	Offering	
-		NVIDIA [®] Quadro [®] P620 2GB 1st GFX	
		NVIDIA® Quadro® P1000 2GB 1st GFX	
		AMD Radeon Pro WX 3100 2GB 1st GFX	

Technical Specifications - Processors

Intel® Xeon® Xeon® processor E-2100 family

Intel® Xeon® E-2176G 6C 3.7/4.7 HT 80W CPU Intel® Xeon® E-2174G 4C 3.8/4.7 HT 71W CPU Intel® Xeon® E-2144G 4C 3.6/4.5 HT 71W CPU Intel® Xeon® E-2136 6C 3.3/4.5 HT 80W CPU Intel® Xeon® E-2126G 6C 3.3/4.5 nHT 80W CPU Intel® Xeon® E-2124G 4C 3.4/4.5 nHT 71W CPU Intel® Xeon® E-2104G 4C 3.2/3.2 nHT 65W CPU

8th generation Intel® CoreTM processor family

Intel® CoreTM i7-8700K 3.7 2666 6C CPU Intel® CoreTM i7+8700K (Core i7 and 16GB Intel® OptaneTM memory*,**) 3.7 2666 6C CPU Intel® CoreTM i7-8700 3.2 26666 6C CPU Intel® CoreTM i7+8700 (Core i7 and 16GB Intel® OptaneTM memory*,**) 3.2 26666 6C CPU Intel® CoreTM i5-8600 3.1 2666 6C CPU Intel® CoreTM i5-8600 (Core i5 and 16GB Intel® OptaneTM memory*,**) 3.1 2666 6C CPU Intel® CoreTM i5-8500 3.0 2666 6C CPU Intel® CoreTM i5-8500 (Core i5 and 16GB Intel® OptaneTM memory*,**) 3.0 2666 6C CPU

8th generation Intel® CoreTM i3/Pentium processor family

Intel[®] Core[™] i3-8100 3.6 2400 4C CPU Intel[®] Pentium[®] G5400 3.7 2400 2C CPU

*Intel® OptaneTM memory (cache) is sold separately. Intel® OptaneTM memory system acceleration does not replace or increase the DRAM in your system. Available for HP commercial desktops and notebooks and for select HP workstations (HP Z240 Tower/SFF, Z2 Mini, ZBook Studio, 15 and 17 G5) and requires a SATA HDD, 7th Gen or higher Intel® CoreTM processor or Intel® Xeon® processor E3-1200 V6 product family or higher, BIOS version with Intel® OptaneTM supported, Windows 10 version 1703 or higher, M.2 type 2280-S1-B-M connector on a PCH Remapped PCIe Controller and Lanes in a x2 or x4 configuration with B-M keys that meet NVMeTM Spec 1.1, and an Intel® Rapid Storage Technology (Intel® RST) 15.5 driver.

**16GB Intel[®] OptaneTM memory Available Fall 2018

SATA Hard Drives for HP Workstations	500GB SATA 7200 rpm 6Gb/s 3.5" HDD	Capacity Height Width	500GB 1 in; 2.54 cm Media Diameter	3.5 in; 8.9 cm
		Interface	Physical Size	4 in; 10.17 cm
		Synchronous Transfer Rate (Maximum)	Serial ATA (6.0Gb/s), NC Up to 600MB/s	LQ enabled
		Buffer	32MB	
		Seek Time (typical reads	s, Single Track	2 ms
		includes controller	Average	11 ms
		overhead, including settling)	Full Stroke	21 ms
		Rotational Speed	7,200 rpm	
		Logical Blocks	976,773,168	
		Operating Temperatur	e 41° to 131° F (5° to 55°	C)
	1TB SATA 7200 rpm	Capacity	1 Terabyte (1000 GB)	
	6Gb/s 3.5" HDD	Height	1 in; 2.54 cm	
		Width	Media Diameter	3.5 in; 8.9 cm
			Physical Size	4 in; 10.17 cm
		Interface	Serial ATA (6.0Gb/s), NO	Q enabled
		Synchronous Transfer Rate (Maximum)	Up to 600 MB/s	
		Buffer	64MB	
		Seek Time (typical reads	s, Single Track	2 ms
		includes controller overhead, including	Average	11 ms
		settling)	Full Stroke	21 ms
		Rotational Speed	7,200 rpm	
		Logical Blocks	1,953,525,168	
		Operating Temperatur	e 41° to 131° F (5° to 55°	C)

2.0TB SATA 7	•	Capacity	2ТВ	
6Gb/s 3.5" HDD		Height	1 in; 2.54 cm	_
		Width	Media Diameter	3.5 in; 8.9 cm
			Physical Size	4 in; 10.17 cm
		Interface Serial ATA (6.0 Gb/s), N		.Q Enabled
		Synchronous Transfer Rate (Maximum)	Up to 600MB/s	
		Buffer	64MB	
		Seek Time (typical reads, includes controller	Single Track	1.0 ms
		overhead, including	Average	11 ms
		settling)	Full Stroke	18 ms
		Rotational Speed	7,200 rpm	
		Logical Blocks	3,907,029,168	
		Operating Temperature	41° to 131° F (5° to 55° (<u>_</u>)
4TD CATA 7000		Caracity	170	
1TB SATA 7200 3.5" HDD (Ente	-		1TB	
Class)	-	Protocol	SATA	
		Form Factor	3.5"	
		Controller	AHCI 2.0M hours	
		Reliability (MTBF)		
		Rated Power On Hours	8760/yr	
		Annualized Failure Rate (based on Rated POH)	<0.62%	
		Rated for 24/7/365 operation	YES	
		Physical Size (Height)	1 in; 2.54 cm	
		Physical Size (Width)	4 in; 10.17 cm	
		Media Diameter	3.5 in; 8.9 cm	
		Interface	Serial ATA (6Gb/s), NCQ	enabled
		Synchronous Transfer Rate (Maximum)	Up to 600MB/s	
		Buffer	128MB	
		Seek Time (typical reads,	Single Track	0.32ms
		includes controller	Average	7.45ms
		overhead, including settling)	Full Stroke	14.2ms
		Operating Temperature	41° to 140° F (5° to 60°	C)
		Performance	Sequential Read	up to 226MB/s
			Sequential Write	up to 226MB/s
		Enterprise Class Features	-	
		•	J	

4TB SATA 7200 rpm 6Gb/s	1 2	4TB		
3.5" HDD (Enterprise Class)	Protocol	SATA		
(Enterprise Glass)	Form Factor	3.5"		
	Controller	AHCI		
	Reliability (MTBF)	2.0M hours		
	Rated Power On Hours	8760/yr		
	Annualized Failure Rate (based on Rated POH)	<0.62%		
	Rated for 24/7/365	YES		
	Operation			
	Physical Size (Height)	rsical Size (Height) 1 in; 2.54 cm		
	Physical Size (Width)	4 in; 10.17 cm		
	Media Diameter	3.5 in; 8.9 cm		
	Interface	Serial ATA (6Gb/s), NCQ e	enabled	
	Synchronous Transfer	Up to 600MB/s		
	Rate (Maximum)			
	Buffer	128MB		
	Seek Time (typical reads	, Single Track	0.7ms	
	includes controller overhead, including	Average	8.5ms	
	settling)	Full Stroke	15.7ms	
	Operating Temperature 41° to 131° F (5° to 55° C)			
	Performance	Sequential Read	up to 226MB/s	
		Sequential Write	up to 226MB/s	
	Enterprise Class Features	High Reliability		
	-	High Reliability		
6TB SATA 7200 rpm	Capacity	High Reliability 6TB		
6Gb/s 3.5" HDD	Capacity Protocol			
•	Capacity Protocol Form Factor	6TB SATA 3.5"		
6Gb/s 3.5" HDD	Capacity Protocol Form Factor Controller	6TB SATA 3.5" AHCI		
6Gb/s 3.5" HDD	Capacity Protocol Form Factor Controller Reliability (MTBF)	6TB SATA 3.5" AHCI 2.0M hours		
6Gb/s 3.5" HDD	Capacity Protocol Form Factor Controller Reliability (MTBF) Rated Power On Hours	6TB SATA 3.5" AHCI 2.0M hours 8760/yr		
6Gb/s 3.5" HDD	Capacity Protocol Form Factor Controller Reliability (MTBF)	6TB SATA 3.5" AHCI 2.0M hours		
6Gb/s 3.5" HDD	Capacity Protocol Form Factor Controller Reliability (MTBF) Rated Power On Hours Annualized Failure Rate	6TB SATA 3.5" AHCI 2.0M hours 8760/yr		
6Gb/s 3.5" HDD	Capacity Protocol Form Factor Controller Reliability (MTBF) Rated Power On Hours Annualized Failure Rate (based on Rated POH) Rated for 24/7/365	6TB SATA 3.5" AHCI 2.0M hours 8760/yr <0.44%		
6Gb/s 3.5" HDD	Capacity Protocol Form Factor Controller Reliability (MTBF) Rated Power On Hours Annualized Failure Rate (based on Rated POH) Rated for 24/7/365 Operation	6TB SATA 3.5" AHCI 2.0M hours 8760/yr <0.44% YES		
6Gb/s 3.5" HDD	Capacity Protocol Form Factor Controller Reliability (MTBF) Rated Power On Hours Annualized Failure Rate (based on Rated POH) Rated for 24/7/365 Operation Physical Size (Height)	6TB SATA 3.5" AHCI 2.0M hours 8760/yr <0.44% YES 1 in; 2.54 cm		
6Gb/s 3.5" HDD	Capacity Protocol Form Factor Controller Reliability (MTBF) Rated Power On Hours Annualized Failure Rate (based on Rated POH) Rated for 24/7/365 Operation Physical Size (Height) Physical Size (Width)	6TB SATA 3.5" AHCI 2.0M hours 8760/yr <0.44% YES 1 in; 2.54 cm 4 in; 10.17 cm	enabled	
6Gb/s 3.5" HDD	Capacity Protocol Form Factor Controller Reliability (MTBF) Rated Power On Hours Annualized Failure Rate (based on Rated POH) Rated for 24/7/365 Operation Physical Size (Height) Physical Size (Width) Media Diameter	6TB SATA 3.5" AHCI 2.0M hours 8760/yr <0.44% YES 1 in; 2.54 cm 4 in; 10.17 cm 3.5 in; 8.9 cm	enabled	
6Gb/s 3.5" HDD	Capacity Protocol Form Factor Controller Reliability (MTBF) Rated Power On Hours Annualized Failure Rate (based on Rated POH) Rated for 24/7/365 Operation Physical Size (Height) Physical Size (Width) Media Diameter Interface Synchronous Transfer	6TB SATA 3.5" AHCI 2.0M hours 8760/yr <0.44% YES 1 in; 2.54 cm 4 in; 10.17 cm 3.5 in; 8.9 cm Serial ATA (6Gb/s), NCQ e	enabled	
6Gb/s 3.5" HDD	Capacity Protocol Form Factor Controller Reliability (MTBF) Rated Power On Hours Annualized Failure Rate (based on Rated POH) Rated for 24/7/365 Operation Physical Size (Height) Physical Size (Width) Media Diameter Interface Synchronous Transfer Rate (Maximum)	6TB SATA 3.5" AHCI 2.0M hours 8760/yr <0.44% YES 1 in; 2.54 cm 4 in; 10.17 cm 3.5 in; 8.9 cm Serial ATA (6Gb/s), NCQ e Up to 600MB/s 128MB	enabled 0.7ms	
6Gb/s 3.5" HDD	Capacity Protocol Form Factor Controller Reliability (MTBF) Rated Power On Hours Annualized Failure Rate (based on Rated POH) Rated for 24/7/365 Operation Physical Size (Height) Physical Size (Width) Media Diameter Interface Synchronous Transfer Rate (Maximum) Buffer Seek Time (typical reads includes controller	6TB SATA 3.5" AHCI 2.0M hours 8760/yr <0.44% YES 1 in; 2.54 cm 4 in; 10.17 cm 3.5 in; 8.9 cm Serial ATA (6Gb/s), NCQ e Up to 600MB/s 128MB ,Single Track		
6Gb/s 3.5" HDD	Capacity Protocol Form Factor Controller Reliability (MTBF) Rated Power On Hours Annualized Failure Rate (based on Rated POH) Rated for 24/7/365 Operation Physical Size (Height) Physical Size (Width) Media Diameter Interface Synchronous Transfer Rate (Maximum) Buffer Seek Time (typical reads includes controller overhead, including	6TB SATA 3.5" AHCI 2.0M hours 8760/yr <0.44% YES 1 in; 2.54 cm 4 in; 10.17 cm 3.5 in; 8.9 cm Serial ATA (6Gb/s), NCQ e Up to 600MB/s 128MB , Single Track Average	0.7ms 8.5ms	
6Gb/s 3.5" HDD	Capacity Protocol Form Factor Controller Reliability (MTBF) Rated Power On Hours Annualized Failure Rate (based on Rated POH) Rated for 24/7/365 Operation Physical Size (Height) Physical Size (Width) Media Diameter Interface Synchronous Transfer Rate (Maximum) Buffer Seek Time (typical reads includes controller	6TB SATA 3.5" AHCI 2.0M hours 8760/yr <0.44% YES 1 in; 2.54 cm 4 in; 10.17 cm 3.5 in; 8.9 cm Serial ATA (6Gb/s), NCQ e Up to 600MB/s 128MB ,Single Track Average Full Stroke	0.7ms 8.5ms 15.7ms	

		Performance	Sequential Read	up to 226MB/s
			Sequential Write	up to 226MB/s
		Enterprise Class Features	High Reliability	
	500GB SATA 7.2K SED SFF	Capacity	500GB	
	HDD	Height	0.275 in; 0.7 cm	
		Width	Media Diameter	2.5 in; 6.36 cm
			Physical Size	2.75 in; 6.99 cm
		Interface	Up to 600MB/s	
		Synchronous Transfer Rate (Maximum)	128MB	
		Buffer	64MB	
		Seek Time (typical reads	,Single Track	1ms
		includes controller	Average	4.2ms
		overhead, including settling)	Full Stroke	25ms (typical)
		Rotational Speed	7,200 rpm	
		Operating Temperature	•	C)
HP Solid State Drives	HP 256GB SATA 6Gb/s SSD	Capacity	256GB	
(SSDs) for Workstations		Height	0.28 in; 0.7 cm	
		Interface	SATA 6Gb/s	
		Synchronous Transfer Rate (Maximum)	Up to 500MB/s (Sequen	tial Read)
		Operating Temperature	32° to 158° F (0° to 70°	C)
	HP 256GB SATA 6Gb/s SED Opal 2 SSD	• •	256GB	
	0pal 2 330	Height	0.28 in; 0.7 cm	
		Width	Physical Size	
		Interface	6Gb/s SATA	
		Synchronous Transfer Rate (Maximum)	Up to 550MB/s (Sequen	tial Read)
		Operating Temperature	32° to 158° F (0° to 70°	C)
	HP 512 GB SATA 6Gb/s SSD	Capacity	512GB	
	550	Height	0.28 in; 0.7 cm	
		Width	Physical Size	2.5 in; 6.36 cm
		Interface	SATA 6Gb/s	
		Synchronous Transfer Rate (Maximum)	Up to 550MB/s (Sequent	:ial Read)
		Operating Temperature	32° to 158° F (0° to 70° (C)

2.5 in; 6.36 cm

92K IOPS

83K IOPS

Technical Specifications - Hard Drives HP 1TB SATA 6Gb/s SSD Capacity 1TB Height 0.28 in; 0.7 cm Width **Physical Size** Interface 6Gb/s SATA Synchronous Transfer Up to 500MB/s (Sequential Read) Rate (Maximum) **Operating Temperature** 32° to 158° F (0° to 70° C) HP 2TB SATA 6Gb/s SSD Capa Prote

Capacity	2TB	
Protocol	SATA	
Form Factor	2.5"	
Controller	AHCI	
NAND Type	3D TLC	
Endurance	400TBW (TB Written)	
Reliability (MTTF)	1.5M hours	
Physical Size (Height)	0.28 in; 0.7 cm	
Physical Size (Width)	2.5 in; 6.36 cm	
Interface	SATA 6Gb/s	
Synchronous Transfer Rate (Maximum)	Up to 550MB/s (Sequen	tial Read)
Operating Temperature	32° to 158° F (0° to 70°	C)
Performance	Sequential Read	530 MB/s
	Sequential Write	500 MB/s

Random Read

Random Write

PCIe SSDs for HP Workstations	HP Z Turbo Drv G2 256GB TLC PCIe SSD (Z2 MB)	Capacity	256GB	
		Protocol	PCIe	
		Form Factor	M.2 in native slot on	motherboard
		Controller	NVMe	
		NAND Type	3D TLC	
		Endurance	75TBW (TB Written)	
		Reliability (MTBF)	1.5M hours PCI Express 3.0 x4 electrical x4 physical 32° to 158° F (0° to 70° C)	
		Interface		
		Operating Temperature		
		Performance	Sequential Read	2800 MB/s
			Sequential Write	320 MB/s (1100 MB/s max/Turbo)
			Random Read	250K IOPS
			Random Write	180K IOPS

HP Z Turbo Drv G2 512GB	Capacity	512GB		
TLC PCIe SSD (Z2 MB)	Protocol	PCIe		
	Form Factor	M.2 in native slot on mo	therboard	
	Controller	NVMe		
	NAND Type	3D TLC		
	Endurance	150TBW (TB Written)		
	Reliability (MTBF)	1.5M hours		
	Interface	PCI Express 3.0 x4 elect	rical x4 physical	
	Operating Temperature	32° to 158° F (0° to 70° (C)	
	Performance	Sequential Read	2800 MB/s	
		Sequential Write	660 MB/s (1600 MB/s max/Turbo)	
		Random Read	260K IOPS	
		Random Write	260K IOPS	
HP Z Turbo Drv G2 1TB TLC	Capacity	1TB		
PCIe SSD (Z2 MB)	Protocol	PCIe		
	Form Factor	M.2 in native slot on mo	therboard	
	Controller	NVMe		
	NAND Type	3D TLC		
	Endurance	300TBW (TB Written)		
	Reliability (MTBF)	1.5M hours		
	Interface	PCI Express 3.0 x4 electr	ical x4 physical	
	Operating Temperature	32° to 158° F (0° to 70° (2)	
	Performance	Sequential Read	3000 MB/s	
		Sequential Write	1150 MB/s (1700 MB/s max/Turbo)	
		Random Read	360K IOPS	
		Random Write	330K IOPS	

HP Z2 Tower G4 Workstation

Intel® 905p Series AIC PCIe SSD	Intel® 9005p Series AIC 280GB PCIe SSD	Capacity Protocol Form Factor	280GB PCIe PCIe Card, Half Height	
		Controller	NVMe	
		NVM Туре	3DXPoint	
		Endurance	5.11 PBW (PB Written)	
		Reliability (MTBF)	1.6M hours	
		Operating Temperature	32° to 185° F (0° to 85°	C)
		Performance	Sequential Read	2730 MB/s
			Sequential Write	2280 MB/s
			Random Read	587K IOPS
			Random Write	559K IOPS
	Intel® 905p Series AIC 480GB PCIe SSD	Capacity	480TB	
		Protocol	PCIe	
		Form Factor	PCIe Card, Half Height	
		Controller	NVMe	
		NVM Туре	3DXPoint	
		Endurance	8.76 PBW (PB Written)	
		Reliability (MTBF)	1.6M hours	
		Operating Temperature	32° to 185° F (0° to 85° C)	
		Performance	Sequential Read	27100 MB/s
			Sequential Write	2280 MB/s
			Random Read	582K IOPS
			Random Write	561K IOPS

Technical Specifications - Graphics

Integrated Intel® ∪HD Graphics (Z2 G4)	Form Factor	Integrated in select Intel® Xeon® E, Intel® Core TM i7, and Intel® Core TM i5 processors.
		Check specific platform specifications for selections.
	Graphics Controller	Intel® UHD Graphics
	Memory	Unified Memory Architecture (UMA) frame buffer. Graphics memory is shared with system memory. Size selectable between 64 MB to 1024 MB via BIOS setting. Default size is 64 MB. Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (Intel® DVMT 5.0), to provide an optimal balance between graphics and system memory use.
	Connectors	Check system platform specifications where Intel® UHD Graphics are available.
	Maximum Resolution	Display Port: 4096 x 2160 DVI: 1920x1200 VGA: 2048x1536 NOTE: For DVI and VGA outputs, separate adapters may be required.
	Shading Architecture	Shader Model 5.0 (It's under confirmation with Intel® for the latest version, TBD)
	Supported Graphics APIs	OpenGL 4.4 DirectX 12
	Available Graphics Drivers	Windows 10

NVIDIA® Quadro® P400 2GB Graphics	Form Factor	Dimensions: 2.713"? H x 5.7"? L Single Slot, Low Profile Cooling: Active Weight: 129 grams
	Graphics Controller	NVIDIA® Quadro® P400 Graphics Card GP107-825 GPU 256 CUDA cores Max Power: 30 Watts
	Bus Type	PCI Express 3.0 x16
	Memory	Size: 2 GB GDDR5, 2000 MHz Memory Interface: 64-bit Memory Bandwidth: 32 GB/s
	Connectors	3mDP Outputs*
	Maximum Resolution	DisplayPort™ 1.4: - up to 3x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)
	Image Quality Features	10-bit internal display processing pipeline 10-bit scan-out support
	Display Output	3 mDP Connectors
	Shading Architecture	Full Microsoft DirectX 12 Shader Model 5.1
	Supported Graphics APIs	OpenGL 4.5 DirectX 12 Vulkan 1.0 API support includes: CUDA C, CUDA C++, DirectCompute , OpenCL

Technical Specifications - Graphics	
Available Grap Drivers	hics Microsoft Windows 10 Microsoft Windows 8.1 Microsoft Windows 7 Linux®
	HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
Notes	*P400, P600 and P1000 only have mini-DisplayPort TM (mDP) video ports. Note 1: Two mDP-to-DP adapters will ship with each P400, P600 or P1000 configured in HP Z Workstations Compatibles. Note 2: AMO kits for P400, P600, P1000 and Adapters will ship in July 2017.
	 Two mDP-to-DP Adapters are included in the P400, P600 and P1000 AMO kits. If mDP-to-DP Adapters are needed, Adapters can be ordered separately:
	- 2KW86A6 - HP (Bulk 4) miniDP-to-DP Adapter Cables
	- 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

NVIDIA® Quadro® P600 2GB Graphics	Form Factor	Low Profile: 2.713 inches in height × 5.7 inches in length
	Graphics Controller	NVIDIA [®] Quadro TM P620
		GP107-825 GPU Number of Cores: 512 CUDA® cores Max. Power: 40W Cooling Solution: Active fan heatsink
	Bus Type	PCI Express x16
	Memory	Size: 2GB DDR5 Clock: 2400Mhz Memory Bandwidth: 80GB/s
	Connectors	4 x mDP 1.4
	Maximum Resolution	DisplayPort [™] 1.4:
		- up to 4x 5120 x 2880 x 24 bpp @ 60Hz
		- supports Multi-Stream Transport (MST)
	Image Quality Feature	s 10-bit internal display processing pipeline
		10-bit scan-out support
	Shading Architecture	Shader Model 5.1
	Supported Graphics APIs	DX11, OpenGL 4.3
	Available Graphics Drivers	Windows® 8 Windows 7 Professional (64-bit and 32-bit) Windows XP Professional (64-bit and 32-bit) Linux® HP qualified drivers may be preloaded or the latest HP qualified drivers are available from the HP support Web site:

Technical Specifications - Graphics

http://welcome.hp.com/country/us/en/support.html

Notes	*P400, P620 and P1000 only have mini-DisplayPort TM (mDP) video ports. Note 1: Two mDP-to-DP adapters will ship with each P400, P620 or P1000 configured in HP Z Workstations Compatibles. Note 2: AMO kits for P400, P600, P1000 and Adapters will ship in July 2017.
	 Two mDP-to-DP Adapters are included in the P400, P620 and P1000 AMO kits. If mDP-to-DP Adapters are needed, Adapters can be ordered separately:
	- 2KW86A6 - HP (Bulk 4) miniDP-to-DP Adapter Cables
	2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables
Form Factor	 Low Profile: 2.713 inches in height × 5.7 inches in length

Radeon [™] Pro WX 4100 4GB Graphics	Form Factor Graphics Controller	Low-Profile Single Slot (6.6"? Length) Polaris 11 Baffin GL XT GPU: 1024 Stream Processors organized into 16 Compute Units Power: 50 Watts Cooling: Active
	Memory	4GB GDDR5 memory Memory Bandwidth: 6 Gbps / 96 GB/s Memory Width: 128 bit
	Connectors	4x Mini DisplayPort TM 1.4 - HDR ready connectors with HBR3 and MST support.
		Factory Configured: Four mDP-to-DP cable adapters included After market option kit: Four mDP-to-DP cable adapters included
		Additional DisplayPort TM -to-VGA or DisplayPort TM -to-DVI adapters are available as Factory Configuration or Option Kit accessories.
	Maximum Resolution	5K support @ 60Hz
		 1x single-cable 5K monitor, or 2x dual-cable 5K monitors 4x 4K support @ 60Hz
	Image Quality Features	Advanced support for 8-bit and 10-bit per RGB color component. High bandwidth scaler for high quality up and downscaling
	Display Output	4 full physical DP1.3 HBR3 / DP1.4 HDR outputs FreeSync support
	GPU Architecture	GCN 4th Generation
	Supported Graphics APIs	DirectX [®] 12
		OpenGL [®] 4.5 OpenCL TM 2.0
		Vulkan [™] 1.0
	Available Graphics Drivers	
		Windows [®] 7 64-bit
		Linux®
		HP qualified drivers may be preloaded or available from the HP support Web site:
		http://welcome.hp.com/country/us/en/support.html
	Notes	1. HDR content requires that the system be configured with a fully

Technical Specifications - Graphics

HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

- 2. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FireProTM and RadeonTM Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions.
- 3. As of September 2016, certified for DisplayPort[™] 1.4 HBR3 and ready for DisplayPort[™] 1.4 HDR based on independent verification by DisplayPort[™] testing authority. HDR content requires that the system be configured with a fully HDR- ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

NVIDIA® Quadro® P1000	Form Factor	Dimensions:2.713"? H x 5.7"? L
4GB Graphics		Single Slot, Low Profile Cooling: Active
		Weight: 129 grams
	Graphics Controller	NVIDIA® Quadro® P1000 Graphics Card GP107-860 GPU
		640 CUDA cores Max Power: 47 Watts
	Bus Type	PCI Express 3.0 x16
	Memory	Size: 4 GB GDDR5, 2500 MHz Memory Interface: 128-bit memory interface
		Memory Bandwidth: 80 GB/s memory bandwidth
	Connectors	4mDP Outputs*
	Maximum Resolution	DisplayPort™ 1.4:
		- up to 4x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)
	Image Quality Features	10-bit internal display processing pipeline 10-bit scan-out support
	Display Output	4 mDP Connectors
	Shading Architecture	Full Microsoft DirectX 12 Shader Model 5.1
	Supported Graphics APIs	OpenGL 4.5 DirectX 12 Vulkan 1.0 API support includes: CUDA C, CUDA C++, DirectCompute , OpenCL
	Available Graphics Drivers	• • •
		HP qualified drivers may be preloaded or available from the HP support Web site:
	Nataa	http://welcome.hp.com/country/us/en/support.html
	Notes	*P400, P620 and P1000 only have mini-DisplayPort [™] (mDP) video ports.

Technical Specificatio	ons - Graphics	
		Note 1: Two mDP-to-DP adapters will ship with each P400, P600 or P1000 configured in HP Z Workstations Compatibles. Note 2: AMO kits for P400, P600, P1000 and Adapters will ship in July 2017.
		 Two mDP-to-DP Adapters are included in the P400, P600 and P1000 AMO kits. If mDP-to-DP Adapters are needed, Adapters can be
		ordered separately:
		- 2KW86A6 - HP (Bulk 4) miniDP-to-DP Adapter Cables
		- 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables
NVIDIA® Quadro® P2000 5GB Graphics	Form Factor	Dimensions: 4.4"?Hx7.9"?L Single Slot Cooling: Active Weight: 260 grams
	Graphics Controller	NVIDIA® Quadro® P2000 Graphics Card Power: 75 Watts
	Bus Type	PCI Express 3.0 x16
	Memory	Size: 5GB GDDR5 Memory Bandwidth: 140 GB/s Memory Width: 160-bit
	Connectors	4x DisplayPort TM 1.4
		Factory Configured Option: No adapter included with card After Market Option: No video cable adapter included
		Additional DVI to VGA, DisplayPort TM to VGA, DisplayPort TM to DVI, and DisplayPort TM to Dual-Link DVI adapters available as accessories.
	Maximum Resolution	DisplayPort TM : - up to 5120 x 2880 x 24 bpp @ 60Hz - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST) DP 1.3 & 1.4 ready.
		DL-DVI(I) output: - up to 2560 x 1600 x 32 bpp @ 60 Hz
		Single Link-DVI(I) output: - up to 1920 x 1200 x 32 bpp @ 60Hz
		HDMI 2.0 (requires DP to HDMI adapter): 5120 x 2880 x 24 bpp @ 60Hz
	Image Quality Features	12-bit internal display pipeline (hardware support for 12-bit scanout on supported panels, applications and connection)
		Stereoscopic 3D display support including NVIDIA® 3D Vision TM technology, NVIDIA® Mosaic and nView.

Technical Specifications - Graphics	
Display Output	Maximum number of displays - 4 direct attached monitors
	Maximum number of monitors across all available Quadro® P2000 outputs is 4.
Shading Architecture	Shader Model 5.1
Supported Graphics APIs	OpenGL [®] 4.5 DirectX [®] 12
	API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran software
Available Graphics Drivers	Microsoft Windows 10 Microsoft Windows 7 Professional 64bit Linux - Full OpenGL implementation, complete with NVIDIA® and ARB extensions
	HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
Notes 1.	Quadro P2000 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately.
2.	Quadro P2000 offered as an After Market Option does not include video cables. Video cable adapters must be ordered separately.

Radeon™ Pro WX 7100 8GB Graphics	Form Factor Graphics Controller	Full-Height Single Slot (9.5"? Length) Radeon™ Pro WX 7100 graphics GPU: 2304 Stream Processors organized into 36 Compute Units Power: 130 Watts Cooling: Active
	Memory	8GB GDDR5 memory Memory Bandwidth: 7 Gbps / 224 GB/s Memory Width: 256 bit
	Connectors	4x Display Port 1.4 - HDR ready connectors with HBR3 and MST support. Factory Configured: No video cable adapter included After market option kit: No video cable adapter included Additional DisplayPort TM -to-VGA or DisplayPort TM -to-DVI adapters are available as Factory Configuration or Option Kit accessories.
	Maximum Resolution	5K support @ 60Hz • 1x single-cable 5K monitor, or 2x dual-cable 5K monitors
	Image Quality Features	Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component. High bandwidth scaler for high quality up and downscaling

Technical Specifications - Graphics

4 full physical DP1.3 HBR3 / DP1.4 HDR outputs FreeSync support
GCN 4th Generation DirectX [®] 12 OpenGL [®] 4.5 OpenCL TM 2.0 Vulkan TM 1.0
Windows 10 64-bit Windows® 7 64-bit Linux®
HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
 HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support. Radeon VR Ready Creator Products are select Radeon Pro and AMD FirePro™ GPUs that meet or exceed the Oculus Rift or HTC Vive recommended specifications for video cards/GPUs. Other hardware (including CPU) and system requirements recommended by Oculus Rift or HTC Vive should also be met in order to operate the applicable HMDs as intended. As VR technology, HMDs and other VR hardware and software evolve and/or become available, these criteria may change without notice. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

NVIDIA® Quadro® P4000 8GB Graphics	Form Factor	Dimensions: 4.4"?H x 9.5"?L Single-slot, full-height Weight: 475 grams (without extender)
	Graphics Controller	NVIDIA® Quadro® P4000 Graphics Card GPU: GP104 with 1792 CUDA cores Power: 120 Watts
	Bus Type	PCI Express 3.0 x16
	Memory	Size: 8GB GDDR5 Memory Bandwidth: 243 GB/s Memory Width: 256-bit

chnical Specifications - Graphics	
Connectors	4 x DisplayPort [™] 1.4 3-pin mini-DIN connector via optional bracket 1 x 6-pin auxiliary power connector 4-pin header for stereo signal SYNC connector for Quadro [®] Sync II 2 x SLI connectors
	Factory Configured Option: No video cable adapter included After Market Option: No video cable adapter included
	Additional DisplayPort TM -to-VGA, DisplayPort TM -to-HDMI, or DisplayPort TM - to- DVI adapters are available as accessories
Maximum Resolution	Dual-link internal TMDS (DVI 1.0): - up to 2560 x 1600 x 32 bpp @ 60 Hz
	Single-link internal TMDS (DVI 1.0): - up to 1920 x 1200 x 32 bpp @ 60 Hz
	HDMI TM 2.0b (requires DP to HDMI adapter): - up to 5120 x 2880 x 24 bpp @ 60Hz
	DisplayPort TM : - up to 4096 x 2160 x 30 bpp @ 60Hz - up to 2560 x 1600 x 30 bpp @ 120 Hz - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)
	Using two DP outputs, the P4000 can drive one dual DP input display with 5120 x 2880 x 30 bpp @ 60Hz resolution.
	Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component. HDCP 2.2 support over DisplayPort TM , DVI, and HDMI connectors NVIDIA [®] 3D Vision TM and other 3D stereo technologies NVIDIA [®] Mosaic and nView
Display Output	Maximum number of displays - 4 direct attached monitors
Shading Architecture	Maximum number of monitors across all available Quadro P4000 outputs is a Shader Model 5.1
	OpenGL 4.5 DirectX 12 Vulcan 1.0
	API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran
	Microsoft Windows 10 Microsoft Windows 7 Linux - Full OpenGL implementation, complete with NVIDIA® and ARB extensions
	HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html

Technical Specifications - Graphics

Notes 1.	Quadro P4000 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately.
2.	Quadro P4000 offered as an After Market Option does not include video cables. Video cable adapters must be ordered separately.
Form Factor	Dimensions: 4.4"?H x 10.5"?L Dual-slot, full-height Weight: 815 grams
Graphics Controller	NVIDIA® Quadro® P5000 Graphics Card GPU: : 2560 NVIDIA® CUDA® cores
Bus Type	PCI Express 3.0 x16
Memory	Size: 16GB GDDR5
	Memory Bandwidth: 288 GB/s Memory Width: 256-bit
	ECC memory (disabled by default)
C	
Connectors	4 x DisplayPort [™] 1.4 (HDR support) DL-DVI (D)
	3-pin mini-DIN connector via optional bracket
	1 x 8-pin auxiliary power connector
	4-pin header for stereo signal SYNC connector for Quadro® Sync II
	2 x SLI connectors
	Factory Configured Option: No video cable adapter included After Market Option: No video cable adapter included
	Additional DisplayPort [™] -to-VGA, DisplayPort [™] -to-HDMI, or DisplayPort [™] - to- DVI adapters are available as accessories
Maximum Resolution	5K support @ 60Hz 1x single-cable 5K monitor, or 2x dual-cable 5k monitors
Image Quality Features	Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component.
	HDCP 2.2 support over DisplayPort TM , DVI, and HDMI connectors NVIDIA® 3D Vision TM and other 3D stereo technologies NVIDIA® Mosaic and nView Desktop Management
Supported Graphics APIs	DirectX®12 , OpenGL® 4.5, OpenCL TM 1.0, Vulkan TM 1.0 Developer API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL TM , Java, Python, ar Fortran
Available Graphics Drivers	Windows 10 64-bit Windows® 7 64-bit Linux®
	2. Form Factor Graphics Controller Bus Type Memory Connectors Connectors Maximum Resolution Image Quality Features Supported Graphics APIs Available Graphics

HP 9.5mm Slim DVD Writer	Description	9.5mm height, tray-load	
	Mounting Orientation	Either horizontal or vertical	
	Interface Type	SATA/ATAPI	
	Dimensions (WxHxD)	128 x 9.5 x 127mm	
	Supported Media Types	DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-R	
	Disc Capacity	DVD-ROM	8.5 GB DL or 4.7 GB standard
	Access Times	Full Stroke DVD	< 200 ms (seek)
		Full Stroke CD	< 200 ms (seek)
	Maximum Data Transfer Rates	CD ROM Read	CD-ROM, CD-R Up to 24X CD-RW Up to 24X
		DVD ROM Read	DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD-R Up to 8X DVD-R Up to 8X
	Power	Source	SATA DC power receptacle
		DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p
		DC Current	5 VDC -< 800 mA typical, <1600 mA maximum
	Operating Environmental	Temperature	41° to 122° F (5° to 50° C)
	(all conditions non-	Relative Humidity	10% to 80%
	condensing)	Maximum Wet Bulb Temperature	84° F (29° C)
	Operating Systems Supported	Windows Vista Business 64	ofessional 32-bit and 64-bit, *, Windows Vista Business 32*, Windows Vista 000, Windows XP Professional or Windows XP
		No driver is required for this operating system.	s device. Native support is provided by the
	Kit Contents	HP SATA DVD Writer drive, i	nstallation guide.

HP 9.5mm Slim DVD-ROM Drive	Description	9.5mm height, tray-load	
	Mounting Orientation	Either horizontal or vertica	al
	Interface Type	SATA / ATAPI	
	Dimensions (WxHxD)	128 x 9.5 x 127mm	
	Disc Capacity	DVD-ROM	Single layer: Up to 4.7 GB Double layer: Up to 8.5 GB
	Access Times	DVD-ROM Single Layer	< 110 ms (typical)
		CD-ROM Mode 1	< 110 ms (typical)
		Full Stroke DVD	< 230 ms (typical)
		Full Stroke CD	< 220 ms (typical)
	Power	Source	SATA DC power receptacle
		DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p
		DC Current	5 VDC - <800mA typical, < 1600 mA maximum
	Operating Environmental	Temperature	41° to 122° F (5° to 50° C)
	(all conditions non-	Relative Humidity	10% to 80%
	condensing)	Maximum Wet Bulb Temperature	84° F (29° C)
	Operating Systems Supported	Windows Vista Business 6	rofessional 32-bit and 64-bit, 4*, Windows Vista Business 32*, Windows Vista 2000, Windows XP Professional or Windows XP
		No driver is required for this device. Native support is provided by the operating system.	
	Kit Contents	9.5mm Slim DVD-ROM Driv	re, slim SATA data/power cable, installation guide
HP 9.5mm Slim BDXL Blu-	Description	9.5mm height, tray-load	
Ray Writer	Mounting Orientation	Either horizontal or vertica	al
	Interface Type	SATA/ATAPI	
	Dimensions (WxHxD)	128 x 9.5 x 127mm	
	Dimensions (WxHxD) Supported Media Types	128 x 9.5 x 127mm BD-ROM	
		BD-ROM BD-R	
		BD-ROM BD-R BD-RE	
		BD-ROM BD-R BD-RE DVD-RAM	
		BD-ROM BD-R BD-RE DVD-RAM DVD+R DVD+R	
		BD-ROM BD-R BD-RE DVD-RAM DVD+R DVD+RW DVD+R DL	
		BD-ROM BD-R BD-RE DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL	
		BD-ROM BD-R BD-RE DVD-RAM DVD+R DVD+RW DVD+R DL	
		BD-ROM BD-R BD-RE DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R	
		BD-ROM BD-R BD-RE DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R	8.5 GB DL or 4.7 GB standard

Access Times	Full Stroke DVD	< 230 ms (seek)
	Full Stroke CD	< 220 ms (seek)
	Blu-ray	< 230 ms (seek) (Full Stroke Blu-ray)
	Startup Time	(Time to drive ready from tray loading) BD-ROM (SL/DL) 25S / 28S BD-R (SL/DL) 25S / 28S BD-RE (SL/DL) 25S / 28S DVD-ROM (SL/DL) 18S / 18S DVD-R (SL/DL) 25S / 25S DVD-RW 25S DVD+R (SL/DL) 25S / 25S DVD+RW 25S DVD+RW 25S DVD+RM 45S DVD-RAM 45S CD-ROM 15S
Maximum Data Transfer Rates	CD ROM Read	CD-ROM, CD-R Up to 24X CD-RW Up to 24X
	DVD ROM Read	DVD-RAM Up to 8X DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X
	Blu-ray	BD-ROM Up to 6X BD-ROM DL Up to 6X BD-R Up to 6X BD-R DL Up to 6X BD-R Up to 6X BD-RE SL/DL Up to 6X
Power	Source	SATA DC power receptacle
	DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p
	DC Current	5 VDC -900 mA typical, 2000mA maximum
Operating Environmental	Temperature	41° to 122° F (5° to 50° C)
(all conditions non-	Relative Humidity	10% to 80%
condensing)	Maximum Wet Bulb Temperature	84° F (29° C)
Operating Systems Supported	and 64-bit, Windows Vista Business 64	2-bit and 64-bit, Windows 7 Professional 32-bit 4*, Windows Vista Business 32*, Windows Vista 2000, Windows XP Professional or Windows XP
	No driver is required for th operating system.	is device. Native support is provided by the
Kit Contents	9.5mm Slim BDXL Blu-Ray data/power cable, installat	Writer, 5.25" ODD Bay adapter/carrier, slim SATA ion guide

Technical Specifications - Optical and Removable Storage

ise, and do not vstems is not y require a DVI o	As Blu-ray is a new format containing new technologies, certain connection, compatibility and/or performance issues may arise, constitute defects in the product. Flawless playback on all system guaranteed. In order for some Blu-ray titles to play, they may red HDMI digital connection and your display may require HDCP supp movies cannot be played on this workstation.	c c g F	DTES	
	USB3.0-SD4.0	ι	escription terface Type	IP SD Media Card Reader
de	 Support USB 2.0 LPM function Support USB 3.0 U1/U2/U3 Power saving mode Support USB 3.0 LTM function. 			
	Dedicated slot in front bezel (orderable option)	[imensions (WxHxD) upported Media Types	
	Secure Digital Card (SD)	9	i.	
	Secure Digital Support up to 2TB		ii.	
	Secure Digital HC (SDHC)	i. S	iii.	
	Secure Digital XC (SDXC)	<i>ı</i> . 9	iv.	
	Support SD USH50 mode	. 9	v.	
	miniSD *1	i. I	vi.	
	. miniSDHC*1	ii. r	vii.	
	i. MicroSD*1	iii. I	viii.	
	MicroSDHC*1	. I	ix.	
	MicroSDXC*1	. N	х.	
	Note: "*1"? means Adapter Needed			
ndows. Systems re, drivers, functionality. ed. ISP fees may pdates. See	No driver is required for this device. Native support is provided to operating system. Not all features are available in all editions or versions of Window may require upgraded and/or separately purchased hardware, di software or BIOS update to take full advantage of Windows function Windows 10 is automatically updated, which is always enabled. I apply and additional requirements may apply over time for upda http://www.microsoft.com.	0 1 2 1 2 1 2 1	perating Systems upported	
ed. ISI Ipdate	Windows 10 is automatically updated, which is always enabled. I apply and additional requirements may apply over time for upda	۱ م		

Drive Enclosure

Interface Type

HP DX115 Removable

Compatible with SATA or SAS controllers. Offers 6Gb/s performance when used with 6Gb/s HDDs.

Dimensions (WxHxD)	14.76 cm x 4.11 cm x 20.5 cm (5.81in x 1.62 in x 8.08 in)
Weight	Frame and Carrier: 1.73 kg (3.8 lbs)
	Carrier: 0.45 kg (1 lbs)

Technical Specifications - Controller Cards

HP Thunderbolt TM 3 PCIe 3-port I/O Card	Data Transfer Rate Devices Supported Bus Type Ports	Supports up to 40 Gb/s 40,000 Mb/s) Thunderbolt TM certified devices PCIe card, full or half height PCIe slots One USB 3.1 Type-C connector (Rear)
	Internal Connectors	One 60-pin board-to-board (FlexIO) connector
	System Requirements	Windows 10 RS3 64-bit, Intel® i5 series or higher processor, 4-GB RAM, 20- GB Hard Drive, available PCIe slot.
	Temperature - Operating	50° to 131° F (10° to 55° C)
	Temperature - Storage	-22° to 140° F (-30° to 60° C)
	Relative Humidity - Operating	20% to 80%
	Compliances	FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD, Taiwan BSMI CNS13438, Korea MIC
	Operating Systems Supported	-Windows 10 RS3 64-bit.
	Kit Contents	HP Thunderbolt TM 3 PCIe 3-port I/O Card, full height and half height bulkhead bracket, DisplayPort TM and GPIO (General-Purpose Input/Output) cable, FlexIO adapter board, Installation documentation and warranty card.

Technical Specifications - Networking and Communications

Integrated Intel® I219LM PCIe GbE Controller	Connector Controller	RJ-45 Intel® I217LM GbE platform LAN connect networking controller
(Intel [®] vPro TM with Intel [®]	Memory	3 KB Tx and 3KB Rx FIFO packet buffer memory
AMT 12 .0)	Data Rates Supported	10/100/1000 Mbps
	Compliance	802.1as/1588, 802.1p, 802.1Q, 802.3, 802.3ab, 802.3az, 802.3i, 802.3u, 802.3z
	Bus Architecture	PCI Express and SMBus
	Data Transfer Mode	PCIe-based interface for active state operation (S0 state) and SMBus for host and management traffic (Sx low power state)
	Power Requirement	Requires 3.3V (integrated regulators for core Vdc)
	Boot ROM Support	Yes
	Network Transfer Mode	Full-duplex; Half-duplex (not supported for the 1000BASE-T transceiver)
	Network Transfer Rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps
	Management Capabilities	vPro, WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, ACPI, Advanced cable diagnostic, loopback modes, AMT 12.0 support, Circuit Breaker, VLAN, Multicast Listener Discovery (MLD)

Intel® X710-DA2 2-Port	Connector	2 SFP+ Ports
SFP+ 10GbE NIC	Cabling	Twin Axial Cabling up to 10m
	Controller	Intel [®] Ethernet Controller X710-AM2
	Network Transfer Rates	10GbE (with supported 10GBASE-SR transceivers)
	Supported	
	Data Path Width	PCIe Gen3x8 (compatible with x4)
	Power Requirement	4.3W (typical) (with supported 10GBASE-SR transceivers)
	Operating Temperature	32° to 131° F (0° to 55° C)
	Dimensions (HxW)	2.703 x 6.578 inches
	Operating System Driver	Windows 10 64-bit
	Support	Linux®
	Kit Contents	 Intel® X710-DA2 2-Port SFP+ 10GbE NIC with standard height bracket attached Low-profile bracket Product Literature

Technical Specifications - Networking and Communications

HP 10GbE SFP+ SR Transceiver	Operating Temperature Operating Humidity	32°F to 113°F (0°C to 45°C) 0% to 85%, noncondensing
	Dimensions (HxWxD)	0.47 x 0.54 x 2.19 inches
	Kit Contents	HP 10GbE SFP+ SR Transceiver

Intel® X550-T2 2-Port	Connector	2 RJ-45
10GbE NIC	Cabling	10GbE: Cat6a (or better) up to 100m 5GbE and below: Cat5e (or better) up to 100m
	Controller	Intel [®] Ethernet Controller X550
	Network Transfer Rates Supported	10GbE, 5GbE, 2.5GbE, 1GbE, 100MbE
	Data Path Width	PCIe Gen3x4
	Power Requirement	11.2W (typical)
	Operating Temperature	32° to 131° F (0° to 55° C)
	Dimensions (H×W)	5.1 x 2.7 in (without brackets)
	Operating System Driver Support	Windows 10 64-bit Linux®
	Kit Contents	 Intel® X550-T2 2-Port 10GbE NIC with standard height bracket attached Low-profile bracket Product Literature

Aquantia® AQN-108 1-Port	Connector	1 RJ-45
5GbE NIC	Cabling	Cat5e (or better) up to 100m
	Controller	Aquantia [®] AQC108
	Network Transfer Rates Supported	5Gbe, 2.5GbE, 1GbE, 100MbE
	Data Path Width	PCle Gen3x1
	Power Requirement	3.5W (typical)
	Operating Temperature	32° to 131° F (0° to 55° C)
	Dimensions (HxW)	3.72 x 3.18 inches (without brackets)
	Operating System Driver Support	Windows 7 64-bit; Windows 10 64-bit; Linux®
	Kit Contents	 Aquantia AQN-108 1-Port 5GbE NIC with standard height bracket attached Low-profile bracket Product Literature

Technical Specifications - Networking and Communications

Intel® I350-T2 2-Port 1GbE	Connector	2 RJ-45	
NIC	Cabling	Cat5e (or better) up to 100m	
	Controller	Intel® Ethernet I350 Controller	
	Network Transfer Rates Supported	1GbE, 100MbE, 10MbE	
	Data Path Width	PCIe Gen2.1x4	
	Power Requirement	4.4W (typical)	
	Operating Temperature	32° to 131° F (0° to 55° C)	
	Dimensions (HxW)	2.75 x 5.5 inches (without brackets)	
	Operating System Driver Support	Windows 7 64-bit; Windows 10 64-bit; Linux®	
	Kit Contents	 Intel® I350-T2 2-Port 1GbE NIC with standard height bracket attached Low-profile bracket Product Literature 	
Intel® 1350-T4 4-Port 1GbE	Connector	4 RJ-45	
NIC	Cabling	Cat5e (or better) up to 100m	
	Controller	Intel® Ethernet I350 Controller	
	Network Transfer Rates Supported	1GbE, 100MbE, 10MbE	
	Data Path Width	PCIe Gen2.1x4	
	Power Requirement	5W (typical)	
	Operating Temperature	32° to 131° F (0° to 55° C)	
	Dimensions (HxW)	2.75 x 5.5 inches (without brackets)	
	Operating System Driver Support	Windows 7 64-bit; Windows 10 64-bit; Linux®	
	Kit Contents	 Intel® I350-T4 4-Port 1GbE NIC with standard height bracket attached Low-profile bracket Product Literature 	
Intel® 9560 802.11ac, BT 5, M.2	WLAN Standards	802.11a/b/g/n/ac, 802.11d, 802.11e, 802.11h, 802.11i, 802.11w, 802.11r, 802.11k, 802.11v 802.11ac Wave 2 (up to 1.73Mbps, 160MHz Channels, MU-MIMO)	
	Antenna	2x2 Dual-Band	
	Bluetooth Standards	5	
	Operating Temperature	32° to 131° F (0° to 55° C)	
	Interface	M.2 CNVio	
	Dimensions	M.2 2230	
	Kit Contents	Not Available	

Technical Specifications - Other Hardware

 Peatures 2x eSATA ports Bring the same ultra-fast SATA performance that you demand from your internal SATA hard drives to an external eSATA hard drive. Faster transfer rates than existing external storage solutions: USB 2.0 & 1394. Complete motherboard to eSATA PCI bracket solution. Robust and user friendly external eSATA connector. 	HP Power Cord Kit HP Serial Port Adapter 		DM293A PA716A	
Filter option Overview Workstations are deployed in a variety of different ways and in different environments, from under a desk to manufacturing floors. HP Workstations designed a dust filter option to further protect the system against the ingre of dust and other particles over the life of the system. Test have shown a reduction of dust ingress of up to 47% for the HP 22 Tower 64 Workstation platform and is cleanable and serviceable by customers. There is also a BIOS setting that will warn customer when it is time to check and clean their filte dust filter and ther particles over the lifter expression of dust and other particles over the lift expression. There is also a BIOS setting that will warn customer when it is time to check and clean their filte dust filter and be removed dust filter Cleaning and servicing the After removing the filter from the system bezel (dust filter can be removed without the use of tools from the front bezel), either blow it with and wash with water or use a delicate duster (feather duster) to brush off the filter the rinse it with water. Allow the filter half a day to dry at room temperature (25C at 30%-50% humidity) Temperature of water can be 0-70C, due to the dust filter meeting the SQTM 70C humidity test. Suggested water temperature for best user experience is 0-50C. Allow the filter half a day to dry at room temperature (25C at 30%-50% humidity) Temperature of water can be 0-70C, due to the dust filter can be ensure the filter. Any type of corrosive liquid is restricted. Enabling the Check Filter warning in the BIOS: Normal tap water (and most other types of water) can be used to rinse the filter. Any type of corrosive liquid is restricted. Select	HP eSATA PCI Cable Kit		 Bring the same ultra-fast SATA performance that you demand from your internal SATA hard drives to an external eSATA hard drive. Faster transfer rates than existing external storage solutions: USB 2.0 & 1394. Complete motherboard to eSATA PCI bracket solution. 	
dust filter without the use of tools from the front bezel), either blow it with and wash with water or use a delicate duster (feather duster) to brush off the filter the rinse it with water. 2. Allow the filter half a day to dry at room temperature (25C at 30%-50% humidity) 3. Temperature of water can be 0-70C, due to the dust filter meeting the SQTM 70C humidity test. Suggested water temperature for best user experience is 0-50C. 4. Normal tap water (and most other types of water) can be used to rinse the filter. Any type of corrosive liquid is restricted. Enabling the Check Filter warning in the BIOS: Customers must enable the BIOS setting once they receive their filter. 3. Select to enable the Dust Filter replacement reminder, which can be set for 1 30, 60, 90, 120, or 180 days. The Reminder will show during POST after the reminder timer has expired. 4. NOTE: customers who anticipate more dust ingress in their environments	-		environments, from under a desk to manufacturing floors. HP Workstations designed a dust filter option to further protect the system against the ingress	
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should set the reminder for a shorter window. Customers anticipating longe ingress can set the reminder for a longer window. BIOS Warnings Large enterprise customers deploying multiple systems can centrally			should set the reminder for a shorter window. Customers anticipating longer ingress can set the reminder for a longer window.	

Technical Specification	ons - Other Hardware	
		enable/control the BIOS warning using the WMI/BCU tool remotely to set the options below: Dust Filter
		 Disable* Enable Dust Filter Reminder (Days) 15, 30, 60*, 90, 120, and 180
Z2 G4 Dust Filter (Filter Only)	Part Number	T9W48AA
		This is intended to be a replacement filter for the HP Z2 Tower G4 Workstation in the event that the original filter would need to be replaced.
HP Z2 Tower G4 Workstation Front Card Guide Kit	Part Number	M6W78AA
	Features	This front card guide kit is required to enable added mechanical stability when configuring select graphics cards on the HP Z2 Tower G4 Workstation.
		The kit enables added mechanical stability when configuring:
		 3x NVIDIA® NVS NVS 310 or NVS 315 graphics cards
		 2x NVIDIA® NVS 510 graphics cards
		 1x NVS 310 plus 1x NVS 510 graphics cards
		 2x AMD W2100 graphics cards
		1x NVIDIA® Quadro® M4000, M5000 graphics cards
		 1x AMD FirePro W7000 graphics card

Technical Specifications – Miscellaneous Features

MISCELLANEOUS FEATURES

Management Features

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode. Controls
 system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state
 without affecting other elements of the system.
- Intel[®] Wired for Management support; industry wide initiative to make Intel[®] architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button

Serviceability Features

- Dual colored power LED on front of computer to indicate either normal or fault condition
- Diagnostic LED Explanation Table:
 - Power LED will blink red 2 to 5 times, then blink white 2 or more times, then repeat (with beep tones for each blink initially):
 - 2 red + 2 white User must provide file for BIOS recovery (USB storage typically)
 - 2 red + 3 white User must enter a key sequence to proceed with recovery by policy
 - 2 red + 4 white BIOS recovery is in progress
 - 3 red + 2 white Memory could not be initialized
 - 3 red + 3 white Graphics adaptor could not be found
 - 3 red + 4 white Power supply failure / not connected
 - 3 red + 5 white Processor not installed
 - 3 red + 6 white Current processor does not support an enabled feature
 - 4 red + 2 white Processor has exceeded its temperature threshold / system thermal shutdown
 - 4 red + 3 white System internal temperature has exceeded its threshold
 - 5 red + 2 white System controller firmware is not valid
 - 5 red + 3 white System controller detected BIOS is not executing
 - 5 red + 4 white BIOS could not complete initialization / PCA failure
 - 5 red + 5 white System controller rebooted the system after a health or recovery timer triggered
- HP PC Hardware Diagnostics UEFI:
 - This utility enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support
- System/Emergency ROM
- Flash ROM
- CMOS Battery Holder for easy replacement
- Flash Recovery with Video Configuration Record Software5 Aux Power LED on System PCA
- Processor ZIF Socket for easy Upgrade
- Over-Temp Warning on Screen (Requires IM Agents)
- Clear Password Jumper
- DIMM Connectors for easy Upgrade
- Clear CMOS Button
- NIC LEDs (integrated) (Green & Amber)
- Color coordinated cables and connectors
- Tool-less Hood Removal
- Front power switch
- System memory can be upgraded without removing the system board or any internal components
- Tool-less Hard Drive, CD & Diskette Removal
- Green Pull Tabs, and Quick Release Latches for easy Identification

Summary of Changes

Date of change:	Version History:	escription of change:
	From v1 to v2	

title

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